# XL216-512-FB236 Datasheet



# **Table of Contents**

1	xCORE Multicore Microcontrollers
2	XL216-512-FB236 Features
3	Pin Configuration
4	
•	Signal Description
5	Example Application Diagram
6	Product Overview
7	PLL
8	Boot Procedure
9	Memory
10	JTAG
11	Board Integration
12	DC and Switching Characteristics
13	Package Information
14	Ordering Information
	endices
A	Configuration of the XL216-512-FB236
В	Processor Status Configuration
C	Tile Configuration
D	Node Configuration
E	Device Errata
F	JTAG, xSCOPE and Debugging
G	Schematics Design Check List
Н	PCB Layout Design Check List
i i	Associated Design Documentation
i	Related Documentation
K	Revision History
IN.	NCVISIOII   IIISCUIV

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# 1 xCORE Multicore Microcontrollers

The xCORE200 Series is a comprehensive range of 32-bit multicore microcontrollers that brings the low latency and timing determinism of the xCORE architecture to mainstream embedded applications. Unlike conventional microcontrollers, xCORE multicore microcontrollers execute multiple real-time tasks simultaneously and communicate between tasks using a high speed network. Because xCORE multicore microcontrollers are completely deterministic, you can write software to implement functions that traditionally require dedicated hardware.

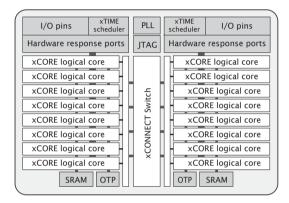


Figure 1: XL216-512-FB236 block diagram

Key features of the XL216-512-FB236 include:

- ► **Tiles**: Devices consist of one or more xCORE tiles. Each tile contains between five and eight 32-bit xCOREs with highly integrated I/O and on-chip memory.
- ▶ Logical cores Each logical core can execute tasks such as computational code, DSP code, control software (including logic decisions and executing a state machine) or software that handles I/O. Section 6.1
- ➤ xTIME scheduler The xTIME scheduler performs functions similar to an RTOS, in hardware. It services and synchronizes events in a core, so there is no requirement for interrupt handler routines. The xTIME scheduler triggers cores on events generated by hardware resources such as the I/O pins, communication channels and timers. Once triggered, a core runs independently and concurrently to other cores, until it pauses to wait for more events. Section 6.2
- ▶ Channels and channel ends Tasks running on logical cores communicate using channels formed between two channel ends. Data can be passed synchronously or asynchronously between the channel ends assigned to the communicating tasks. Section 6.5
- ➤ xCONNECT Switch and Links Between tiles, channel communications are implemented over a high performance network of xCONNECT Links and routed through a hardware xCONNECT Switch. Section 6.6

- ▶ **Ports** The I/O pins are connected to the processing cores by Hardware Response ports. The port logic can drive its pins high and low, or it can sample the value on its pins optionally waiting for a particular condition. Section 6.3
- ► Clock blocks xCORE devices include a set of programmable clock blocks that can be used to govern the rate at which ports execute. Section 6.4
- ▶ Memory Each xCORE Tile integrates a bank of SRAM for instructions and data, and a block of one-time programmable (OTP) memory that can be configured for system wide security features. Section 9
- ▶ PLL The PLL is used to create a high-speed processor clock given a low speed external oscillator. Section 7
- ▶ JTAG The JTAG module can be used for loading programs, boundary scan testing, in-circuit source-level debugging and programming the OTP memory. Section 10

#### 1.1 Software

Devices are programmed using C, C++ or xC (C with multicore extensions). XMOS provides tested and proven software libraries, which allow you to quickly add interface and processor functionality such as USB, Ethernet, PWM, graphics driver, and audio EQ to your applications.

# 1.2 xTIMEcomposer Studio

The xTIMEcomposer Studio development environment provides all the tools you need to write and debug your programs, profile your application, and write images into flash memory or OTP memory on the device. Because xCORE devices operate deterministically, they can be simulated like hardware within xTIMEcomposer: uniquely in the embedded world, xTIMEcomposer Studio therefore includes a static timing analyzer, cycle-accurate simulator, and high-speed in-circuit instrumentation.

xTIMEcomposer can be driven from either a graphical development environment, or the command line. The tools are supported on Windows, Linux and MacOS X and available at no cost from xmos.com/downloads. Information on using the tools is provided in the xTIMEcomposer User Guide, X3766.

# 2 XL216-512-FB236 Features

### ► Multicore Microcontroller with Advanced Multi-Core RISC Architecture

- 16 real-time logical cores on 2 xCORE tiles
- Cores share up to 1000 MIPS
  - Up to 2000 MIPS in dual issue mode
- Each logical core has:
  - Guaranteed throughput of between 1/5 and 1/8 of tile MIPS
  - 16x32bit dedicated registers
- 167 high-density 16/32-bit instructions
  - All have single clock-cycle execution (except for divide)
  - 32x32-64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions

#### ▶ Programmable I/O

- 128 general-purpose I/O pins, configurable as input or output
  - Up to 32 x 1bit port, 12 x 4bit port, 8 x 8bit port, 4 x 16bit port, 2 x 32bit port
  - 8 xCONNECT links
- Port sampling rates of up to 60 MHz with respect to an external clock
- 32 channel ends for communication with other cores, on or off-chip

#### Memory

- 512KB internal single-cycle SRAM (max 256KB per tile) for code and data storage
- 16KB internal OTP (max 8KB per tile) for application boot code

#### ▶ Hardware resources

- 12 clock blocks (6 per tile)
- 20 timers (10 per tile)
- 8 locks (4 per tile)

### ▶ JTAG Module for On-Chip Debug

### ▶ Security Features

- Programming lock disables debug and prevents read-back of memory contents
- AES bootloader ensures secrecy of IP held on external flash memory

### ► Ambient Temperature Range

- Commercial qualification: 0°C to 70°C
   Industrial qualification: -40°C to 85°C
- Speed Grade
  - 20: 1000 MIPS

## **▶** Power Consumption

- 570 mA (typical)
- ▶ 236-pin FBGA package 0.5 mm pitch

# 3 Pin Configuration

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
А	GND	VDDIOL	VDDIOL		TCK	CLK		X1D31	X1D29		X1D41	OTP_ VCC		NC	MODE[0]		X0D29	VDDIOR	GND
В	X0D36	VDDIOL	VDDIOL	TDO	TMS	TRST_ N	X1D33	X1D32	X1D28	X1D26	X1D42	OTP_ VCC	NC	NC	MODE[1]	X0D33	X0D32	VDDIOR	VDDIOR
С	X0D37 XL <sub>0</sub>	X0D38 XL <sub>0</sub>	VDDIOL	TDI	DEBUG_ N	RST_N	X1D10	X1D11	X1D30	X1D27	X1D43	X1D40	NC	NC	X0D31	X0D30	X0D28	X0D26 XL <sup>03</sup> <sub>7</sub>	X0D27 XI <sup>C+</sup>
D		X0D39 XL <sub>0</sub> <sup>2</sup>	X0D40														X0D34 XL <sup>o1</sup> <sub>X</sub> L <sup>o1</sup> <sub>7</sub>	X0D35 XL <sup>02</sup> <sub>7</sub>	
E	X0D43 XLC1	X0D42 XE <sub>0</sub>	X0D41														X0D25 XL <sup>00</sup> <sub>7</sub>	X0D24 XL <sup>10</sup> <sub>7</sub>	X1D01 XL <sub>7</sub>
F	X1D34 XE <sup>2</sup>	X1D35 XE <sub>0</sub>	X1D36 XL <sup>ot</sup>				NC	VDD	VDD	VDDIOT	VDD	VDD	PLL_ AVDD	PLL_ AGND			X1D08 XL <sup>H</sup> <sub>7</sub>	X1D09 XL <sub>7</sub>	X1D00 XL <sub>7</sub> <sup>2</sup>
G		X1D49 XL <sup>H</sup>	X1D50 XL <sub>1</sub>			VDD		GND		GND		GND		VDD			X0D69 XL <sup>c3</sup>	X0D70 XL <sub>g</sub> <sup>04</sup>	
н	X1D53 XL,	X1D52 XL,	X1D51 XL <sub>1</sub> <sup>2</sup>			VDD	GND	GND	GND	GND	GND	GND	GND	VDD			X0D68 XL <sup>02</sup> <sub>5</sub>	X0D67 XL <sub>6</sub> <sup>01</sup>	X0D66 XL <sup>00</sup> <sub>5</sub>
J	X1D54 XL <sup>20</sup>	X1D55 XL <sup>21</sup>	X1D56 XL <sup>22</sup>			VDD		GND		GND		GND		VDD			X0D63 XL <sup>12</sup>	X0D64 XL <sub>6</sub>	X0D65 XL <sub>g</sub>
К		X1D58 XL <sup>24</sup>	X1D57 XL <sup>23</sup>			VDD	GND	GND	GND	GND	GND	GND	GND	VDD			X0D62 XL <sub>6</sub>	X0D61 XL <sub>6</sub> <sup>14</sup>	
L	X1D63 XL <sup>2</sup> <sub>2</sub>	X1D62 XL <sub>2</sub>	X1D61 XL <sup>M</sup> <sub>2</sub>			VDD		GND		GND		GND		VDD			32A X0D58 XL <sup>od</sup> <sub>5</sub>	X0D57 XL <sub>5</sub>	X0D56 XL <sup>22</sup> <sub>S</sub>
М	X1D64 XL <sup>1</sup> <sub>2</sub>	X1D65 XL <sup>0</sup> <sub>2</sub>	X1D66 XL <sup>0</sup> <sub>2</sub>			VDD	GND	GND	GND	GND	GND	GND	GND	VDD			X0D53 XL <sup>0</sup> <sub>5</sub>	X0D54 XL <sub>5</sub>	X0D55 XL <sup>21</sup>
N		X1D67 XL <sup>21</sup>	X1D68 XL <sup>02</sup>			VDD		GND		GND		GND		VDD			32A <b>X0D51</b> XL <sup>2</sup> <sub>5</sub>	X0D52 XL <sup>1</sup> <sub>5</sub>	
Р	X1D70 XL <sup>p4</sup>	X1D69 XL <sup>03</sup> <sub>2</sub>	X1D37 XL <sub>3</sub>			VDD	VDD	VDD	VDD	VDD	VDD	VDD	VDD	NC			X1D07 XL <sup>04</sup>	X0D50 XL <sub>5</sub>	X0D49 XL <sub>5</sub>
R	X1D38 XL <sub>3</sub>	X1D39 XL <sup>2</sup> <sub>1</sub>	X1D17 XL <sub>3</sub>														X1D03 XL <sup>00</sup> <sub>4</sub>	X1D05 XL <sub>4</sub> <sup>02</sup>	X1D06 XL <sup>23</sup>
Т		X1D16 XL <sub>3</sub>	X1D18 XL <sub>3</sub> <sup>00</sup>														X1D02 XL <sub>4</sub>	X1D04 XL <sup>01</sup> <sub>4</sub>	
U	X0D10 XL <sup>c3</sup>	X0D01 XL <sup>62</sup> <sub>3</sub>	X1D19 XL3	X0D00	X0D11	X0D07	X1D12	VDDIOL	NC	NC	GND	NC	X1D24	X0D22	X0D13	X0D23	X0D19 XL <sup>1</sup> <sub>4</sub>	X0D18 XL <sup>2</sup> <sub>4</sub>	X0D17 XL <sub>4</sub>
٧	X1D22 XL <sup>24</sup>	VDDIOL	VDDIOL	X0D04	X0D06	X0D03	X0D08	X0D09	NC	NC	X1D21	X1D14	X1D25	X0D21	X0D14	X0D12	VDDIOR	VDDIOR	X0D16 XL4
w	GND	VDDIOL	X1D23		X0D05	X0D02		X1D13	NC		X1D20	X1D15		X0D20	X0D15		VDDIOR	VDDIOR	GND

# 4 Signal Description

This section lists the signals and I/O pins available on the XL216-512-FB236. The device provides a combination of 1 bit, 4bit, 8bit and 16bit ports, as well as wider ports that are fully or partially (gray) bonded out. All pins of a port provide either output or input, but signals in different directions cannot be mapped onto the same port.

Pins may have one or more of the following properties:

- ▶ PD/PU: The IO pin a weak pull-down or pull-up resistor. On GPIO pins this resistor can be enabled.
- ▶ ST: The IO pin has a Schmitt Trigger on its input.
- ▶ IOL/IOT/IOR: The IO pin is powered from VDDIOL, VDDIOT, and VDDIOR respectively

Power pins (8)									
Signal	Function	Type	Properties						
GND	Digital ground	GND							
OTP_VCC	OTP power supply	PWR							
PLL_AGND	Analog ground for PLL	PWR							
PLL_AVDD	Analog PLL power	PWR							
VDD	Digital tile power	PWR							
VDDIOL	Digital I/O power (left)	PWR							
VDDIOR	Digital I/O power (right)	PWR							
VDDIOT	Digital I/O power (top)	PWR							

	JTAG pins (6)										
Signal	Function	Type	Properties								
RST_N	Global reset input	Input	IOL, PU, ST								
TCK	Test clock	Input	IOL, PD, ST								
TDI	Test data input	Input	IOL, PU								
TDO	Test data output	Output	IOL, PD								
TMS	Test mode select	Input	IOL, PU								
TRST_N	Test reset input	Input	IOL, PU, ST								

	I/O pins (128)												
Signal	Function						Type	Properties					
X0D00		1A <sup>0</sup>					I/O	IOL, PD					
X0D01	XL3 <sup>2</sup> <sub>out</sub>	1B <sup>0</sup>					I/O	IOL, PD					
X0D02			4A <sup>0</sup>	8A <sup>0</sup>	16A <sup>0</sup>	32A <sup>20</sup>	I/O	IOL, PD					
X0D03			4A <sup>1</sup>	8A <sup>1</sup>	16A <sup>1</sup>	32A <sup>21</sup>	I/O	IOL, PD					

(continued)

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Signal		T.					ı	T
X0D05	Signal	Function					Type	Properties
X0D06							-	IOL, PD
X0D07	X0D05						I/O	IOL, PD
X0D08							I/O	IOL, PD
X0D09	X0D07			8A <sup>5</sup>	16A <sup>5</sup>		I/O	IOL, PD
X0D10	X0D08		4A <sup>2</sup>	8A <sup>6</sup>	16A <sup>6</sup>	32A <sup>26</sup>	I/O	IOL, PD
XOD11	X0D09		4A <sup>3</sup>	8A <sup>7</sup>	16A <sup>7</sup>	32A <sup>27</sup>	I/O	IOL, PD
XOD12	X0D10	XL3 <sub>out</sub> 1	C <sub>0</sub>				I/O	IOL, PD
XOD13	X0D11						I/O	IOL, PD
XOD14	X0D12						I/O	IOR, PD
XOD15	X0D13	1	$F^0$				I/O	IOR, PD
X0D16	X0D14		4C <sup>0</sup>	8B <sup>0</sup>	16A <sup>8</sup>	32A <sup>28</sup>	I/O	IOR, PD
X0D17	X0D15		4C <sup>1</sup>	8B1	16A <sup>9</sup>	32A <sup>29</sup>	I/O	IOR, PD
X0D18	X0D16	XL4 <sup>4</sup> <sub>in</sub>	4D <sup>0</sup>	8B <sup>2</sup>	16A <sup>10</sup>		I/O	IOR, PD
X0D19	X0D17	XL4 <sup>3</sup>	4D <sup>1</sup>	8B <sup>3</sup>	16A <sup>11</sup>		I/O	IOR, PD
XOD20	X0D18	XL4 <sup>2</sup>	4D <sup>2</sup>	8B <sup>4</sup>	16A <sup>12</sup>		I/O	IOR, PD
X0D21         4C³ 8B² 16A¹ 32A³¹ I/O IOR, PD           X0D22         1G° IG° IIO         I/O IOR, PD           X0D23         1H° IIO IOR, PD         I/O IOR, PD           X0D24         XL7¹n XIIO IOR, PD         I/O IOR, PD           X0D25         XL7₀ut XI7₀ut IJ° I/O IOR, PD         I/O IOR, PD           X0D26         XL7₃ut AE¹ 8C¹ 16B¹ I/O IOR, PD         I/O IOR, PD           X0D27         XL7₄ut AE¹ 8C¹ 16B¹ I/O IOR, PD         IOR, PD           X0D28         4F° 8C² 16B² I/O IOR, PD         IOR, PD           X0D29         4F¹ 8C³ 16B³ I/O IOR, PD         IOR, PD           X0D30         4F² 8C⁴ 16B⁴ I/O IOR, PD         IOR, PD           X0D31         4F³ 8C⁵ 16B⁵ I/O IOR, PD         IOR, PD           X0D32         4E² 8C⁶ 16B⁶ I/O IOR, PD         IOR, PD           X0D33         4E³ 8C² 16B² I/O IOR, PD         IOR, PD           X0D34         XL7₀ut IK° IV° IOR, PD         I/O IOR, PD           X0D35         XL7₀ut IL° IV° IV° IOR, PD         IOR, PD           X0D36         1M° 8D° 16B³ I/O IOR, PD         IOR, PD           X0D37         XL0¹n IN° 8D¹ 16B³ I/O IOR, PD         IOR, PD           X0D38         XL0¹n IN° 8D¹ 16B³ I/O IOR, PD         IOR, PD           X0D40         XL0¹n 8D² 16B¹ I/O IOR, PD <td>X0D19</td> <td>XL4<sup>1</sup></td> <td>4D<sup>3</sup></td> <td>8B<sup>5</sup></td> <td>16A<sup>13</sup></td> <td></td> <td>I/O</td> <td>IOR, PD</td>	X0D19	XL4 <sup>1</sup>	4D <sup>3</sup>	8B <sup>5</sup>	16A <sup>13</sup>		I/O	IOR, PD
X0D22         1G°         I/O         IOR, PD           X0D23         1H°         I/O         IOR, PD           X0D24         XL7° <sub>II</sub> 1I°         I/O         IOR, PD           X0D25         XL7° <sub>out</sub> 1J°         I/O         IOR, PD           X0D26         XL7° <sub>out</sub> 4E°         8C°         168°         I/O         IOR, PD           X0D27         XL7° <sub>out</sub> 4E°         8C°         168°         I/O         IOR, PD           X0D28         4F°         8C²         168°         I/O         IOR, PD           X0D28         4F°         8C²         168°         I/O         IOR, PD           X0D29         4F°         8C³         168°         I/O         IOR, PD           X0D30         4F²         8C⁴         168⁴         I/O         IOR, PD           X0D31         4F³         8C⁵         168⁵         I/O         IOR, PD           X0D32         4E²         8C⁵         168°         I/O         IOR, PD           X0D33         XL7° <sub>out</sub> 1K°         I/O         IOR, PD           X0D34         XL7° <sub>out</sub> 1K°         I/O         IOR, PD	X0D20		4C <sup>2</sup>	8B <sup>6</sup>	16A <sup>14</sup>	32A <sup>30</sup>	I/O	IOR, PD
X0D23         1H <sup>0</sup> I/O         IOR, PD           X0D24         XL7 <sub>0</sub> <sup>0</sup> n         1I <sup>0</sup> I/O         IOR, PD           X0D25         XL7 <sub>0</sub> <sup>0</sup> ut         1J <sup>0</sup> I/O         IOR, PD           X0D26         XL7 <sub>0</sub> <sup>3</sup> ut         4E <sup>0</sup> 8C <sup>0</sup> 16B <sup>0</sup> I/O         IOR, PD           X0D27         XL7 <sub>0</sub> <sup>4</sup> ut         4E <sup>1</sup> 8C <sup>1</sup> 16B <sup>1</sup> I/O         IOR, PD           X0D28         4F <sup>0</sup> 8C <sup>2</sup> 16B <sup>2</sup> I/O         IOR, PD           X0D29         4F <sup>1</sup> 8C <sup>3</sup> 16B <sup>3</sup> I/O         IOR, PD           X0D30         4F <sup>2</sup> 8C <sup>4</sup> 16B <sup>4</sup> I/O         IOR, PD           X0D31         4F <sup>3</sup> 8C <sup>5</sup> 16B <sup>5</sup> I/O         IOR, PD           X0D32         4E <sup>2</sup> 8C <sup>6</sup> 16B <sup>6</sup> I/O         IOR, PD           X0D33         4E <sup>3</sup> 8C <sup>7</sup> 16B <sup>7</sup> I/O         IOR, PD           X0D34         XL7 <sub>0</sub> <sup>1</sup> ut         1K <sup>0</sup> I/O         IOR, PD           X0D35         XL7 <sub>0</sub> <sup>2</sup> ut         1L <sup>0</sup> I/O         IOR, PD           X0D36         1M <sup>0</sup> 8D <sup>0</sup> 16B <sup>8</sup> I/O         IOL, PD           X0D37         XL0 <sub>in</sub> 1N <sup>0</sup> 8D <sup>1</sup> 16B <sup>9</sup> I/O         IOL, PD	X0D21		4C <sup>3</sup>	8B <sup>7</sup>	16A <sup>15</sup>	32A <sup>31</sup>	I/O	IOR, PD
X0D24         XL700	X0D22	1	G <sup>0</sup>				I/O	IOR, PD
X0D25         XL70ut NOTON         1/0         IOR, PD           X0D26         XL70ut NOTON         4E0 8C0 1680         I/O IOR, PD           X0D27         XL70ut NOTON         4E1 8C1 16B1         I/O IOR, PD           X0D28         4F0 8C2 16B2         I/O IOR, PD           X0D29         4F1 8C3 16B3         I/O IOR, PD           X0D30         4F2 8C4 16B4         I/O IOR, PD           X0D31         4F3 8C5 16B5         I/O IOR, PD           X0D32         4E2 8C6 16B6         I/O IOR, PD           X0D33         4E3 8C7 16B7         I/O IOR, PD           X0D34         XL70ut 1K0         I/O IOR, PD           X0D35         XL70ut 1K0         I/O IOR, PD           X0D36         1M0 8D0 16B8         I/O IOL, PD           X0D37         XL0in 1N0 8D1 16B9         I/O IOL, PD           X0D38         XL0in 1N0 8D1 16B9         I/O IOL, PD           X0D39         XL0in 1N0 8D2 16B1         I/O IOL, PD           X0D40         XL0in 8D4 16B1         I/O IOL, PD           X0D41         XL0in 8D4 16B1         I/O IOL, PD           X0D42         XL0in 8D5 16B13 I/O IOL, PD           X0D43         XL0in 8D6 16B14         I/O IOL, PD           X0D43         <	X0D23	1	H <sup>0</sup>				I/O	IOR, PD
X0D26         XL7 <sub>out</sub> at 20         4E <sup>0</sup> 8C <sup>0</sup> 168 <sup>0</sup> I/O IOR, PD           X0D27         XL7 <sub>out</sub> 4E <sup>1</sup> 8C <sup>1</sup> 168 <sup>1</sup> I/O IOR, PD           X0D28         4F <sup>0</sup> 8C <sup>2</sup> 168 <sup>2</sup> I/O IOR, PD           X0D29         4F <sup>1</sup> 8C <sup>3</sup> 168 <sup>3</sup> I/O IOR, PD           X0D30         4F <sup>2</sup> 8C <sup>4</sup> 168 <sup>4</sup> I/O IOR, PD           X0D31         4F <sup>3</sup> 8C <sup>5</sup> 168 <sup>5</sup> I/O IOR, PD           X0D32         4E <sup>2</sup> 8C <sup>6</sup> 168 <sup>6</sup> I/O IOR, PD           X0D33         4E <sup>3</sup> 8C <sup>7</sup> 168 <sup>7</sup> I/O IOR, PD           X0D34         XL7 <sub>out</sub> 1K <sup>0</sup> I/O IOR, PD           X0D35         XL7 <sub>out</sub> 1L <sup>0</sup> I/O IOR, PD           X0D36         1M <sup>0</sup> 8D <sup>0</sup> 168 <sup>8</sup> I/O IOL, PD           X0D37         XL0 <sub>in</sub> 1N <sup>0</sup> 8D <sup>1</sup> 168 <sup>9</sup> I/O IOL, PD           X0D38         XL0 <sub>in</sub> 1N <sup>0</sup> 8D <sup>2</sup> 168 <sup>10</sup> I/O IOL, PD           X0D39         XL0 <sub>in</sub> 1P <sup>0</sup> 8D <sup>3</sup> 168 <sup>11</sup> I/O IOL, PD           X0D40         XL0 <sub>in</sub> 1P <sup>0</sup> 8D <sup>3</sup> 168 <sup>13</sup> I/O IOL, PD           X0D41         XL0 <sub>in</sub> 8D <sup>4</sup> 168 <sup>12</sup> I/O IOL, PD           X0D42         XL0 <sub>out</sub> 8D <sup>6</sup> 168 <sup>14</sup> I/O IOL, PD           X0D43         XL0 <sub>out</sub> 8D <sup>7</sup> 168 <sup>15</sup> I/O IOL, PD           X0D49	X0D24	XL7 <sup>0</sup> 1	I <sub>0</sub>				I/O	IOR, PD
X0D27         XL7 <sup>4</sup> <sub>out</sub> 4E <sup>1</sup> 8C <sup>1</sup> 16B <sup>1</sup> I/O         IOR, PD           X0D28         4F <sup>0</sup> 8C <sup>2</sup> 16B <sup>2</sup> I/O         IOR, PD           X0D29         4F <sup>1</sup> 8C <sup>3</sup> 16B <sup>3</sup> I/O         IOR, PD           X0D30         4F <sup>2</sup> 8C <sup>4</sup> 16B <sup>4</sup> I/O         IOR, PD           X0D31         4F <sup>3</sup> 8C <sup>5</sup> 16B <sup>5</sup> I/O         IOR, PD           X0D32         4E <sup>2</sup> 8C <sup>6</sup> 16B <sup>6</sup> I/O         IOR, PD           X0D33         4E <sup>3</sup> 8C <sup>7</sup> 16B <sup>7</sup> I/O         IOR, PD           X0D34         XL7 <sup>2</sup> <sub>out</sub> 1K <sup>0</sup> I/O         IOR, PD           X0D35         XL7 <sup>2</sup> <sub>out</sub> 1L <sup>0</sup> I/O         IOR, PD           X0D36         1M <sup>0</sup> 8D <sup>0</sup> 16B <sup>8</sup> I/O         IOL, PD           X0D37         XL0 <sup>4</sup> <sub>in</sub> 1N <sup>0</sup> 8D <sup>1</sup> 16B <sup>9</sup> I/O         IOL, PD           X0D38         XL0 <sup>2</sup> <sub>in</sub> 1P <sup>0</sup> 8D <sup>3</sup> 16B <sup>11</sup> I/O         IOL, PD           X0D40         XL0 <sup>1</sup> <sub>in</sub> 8D <sup>4</sup> 16B	X0D25	XL7 <sub>out</sub> 1	J <sub>0</sub>				I/O	IOR, PD
X0D28       4F <sup>0</sup> 8C <sup>2</sup> 16B <sup>2</sup> I/O IOR, PD         X0D29       4F <sup>1</sup> 8C <sup>3</sup> 16B <sup>3</sup> I/O IOR, PD         X0D30       4F <sup>2</sup> 8C <sup>4</sup> 16B <sup>4</sup> I/O IOR, PD         X0D31       4F <sup>3</sup> 8C <sup>5</sup> 16B <sup>5</sup> I/O IOR, PD         X0D32       4E <sup>2</sup> 8C <sup>6</sup> 16B <sup>6</sup> I/O IOR, PD         X0D33       4E <sup>3</sup> 8C <sup>7</sup> 16B <sup>7</sup> I/O IOR, PD         X0D34       XL7 <sup>1</sup> <sub>out</sub> 1K <sup>0</sup> I/O IOR, PD         X0D35       XL7 <sup>2</sup> <sub>out</sub> 1L <sup>0</sup> I/O IOR, PD         X0D36       1M <sup>0</sup> 8D <sup>0</sup> 16B <sup>8</sup> I/O IOL, PD         X0D37       XL0 <sup>1</sup> <sub>in</sub> 1N <sup>0</sup> 8D <sup>1</sup> 16B <sup>9</sup> I/O IOL, PD         X0D38       XL0 <sup>1</sup> <sub>in</sub> 10 <sup>0</sup> 8D <sup>2</sup> 16B <sup>10</sup> I/O IOL, PD         X0D39       XL0 <sup>2</sup> <sub>in</sub> 1P <sup>0</sup> 8D <sup>3</sup> 16B <sup>11</sup> I/O IOL, PD         X0D40       XL0 <sup>1</sup> <sub>in</sub> 8D <sup>4</sup> 16B <sup>12</sup> I/O IOL, PD         X0D41       XL0 <sup>0</sup> <sub>in</sub> 8D <sup>5</sup> 16B <sup>13</sup> I/O IOL, PD         X0D42       XL0 <sup>0</sup> <sub>out</sub> 8D <sup>6</sup> 16B <sup>14</sup> I/O IOL, PD         X0D43       XL0 <sup>1</sup> <sub>out</sub> 8D <sup>7</sup> 16B <sup>15</sup> I/O IOL, PD         X0D49       XL5 <sup>1</sup> <sub>in</sub> 32A <sup>0</sup> I/O IOR, PD         X0D50       XL5 <sup>3</sup> <sub>in</sub> 32A <sup>1</sup> I/O IOR, PD	X0D26	XL7 <sup>3</sup> out	4E <sup>0</sup>	8C <sup>0</sup>	16B <sup>0</sup>		I/O	IOR, PD
X0D28       4F <sup>0</sup> 8C <sup>2</sup> 16B <sup>2</sup> I/O IOR, PD         X0D29       4F <sup>1</sup> 8C <sup>3</sup> 16B <sup>3</sup> I/O IOR, PD         X0D30       4F <sup>2</sup> 8C <sup>4</sup> 16B <sup>4</sup> I/O IOR, PD         X0D31       4F <sup>3</sup> 8C <sup>5</sup> 16B <sup>5</sup> I/O IOR, PD         X0D32       4E <sup>2</sup> 8C <sup>6</sup> 16B <sup>6</sup> I/O IOR, PD         X0D33       4E <sup>3</sup> 8C <sup>7</sup> 16B <sup>7</sup> I/O IOR, PD         X0D34       XL7 <sup>1</sup> <sub>out</sub> 1K <sup>0</sup> I/O IOR, PD         X0D35       XL7 <sup>2</sup> <sub>out</sub> 1L <sup>0</sup> I/O IOR, PD         X0D36       1M <sup>0</sup> 8D <sup>0</sup> 16B <sup>8</sup> I/O IOL, PD         X0D37       XL0 <sup>1</sup> <sub>in</sub> 1N <sup>0</sup> 8D <sup>1</sup> 16B <sup>9</sup> I/O IOL, PD         X0D38       XL0 <sup>1</sup> <sub>in</sub> 10 <sup>0</sup> 8D <sup>2</sup> 16B <sup>10</sup> I/O IOL, PD         X0D39       XL0 <sup>2</sup> <sub>in</sub> 1P <sup>0</sup> 8D <sup>3</sup> 16B <sup>11</sup> I/O IOL, PD         X0D40       XL0 <sup>1</sup> <sub>in</sub> 8D <sup>4</sup> 16B <sup>12</sup> I/O IOL, PD         X0D41       XL0 <sup>0</sup> <sub>in</sub> 8D <sup>5</sup> 16B <sup>13</sup> I/O IOL, PD         X0D42       XL0 <sup>0</sup> <sub>out</sub> 8D <sup>6</sup> 16B <sup>14</sup> I/O IOL, PD         X0D43       XL0 <sup>1</sup> <sub>out</sub> 8D <sup>7</sup> 16B <sup>15</sup> I/O IOL, PD         X0D49       XL5 <sup>1</sup> <sub>in</sub> 32A <sup>0</sup> I/O IOR, PD         X0D50       XL5 <sup>3</sup> <sub>in</sub> 32A <sup>1</sup> I/O IOR, PD	X0D27	XL7 <sup>4</sup> <sub>out</sub>	4E <sup>1</sup>	8C <sup>1</sup>	16B <sup>1</sup>		I/O	IOR, PD
X0D30         4F²         8C⁴         16B⁴         I/O         IOR, PD           X0D31         4F³         8C⁵         16B⁵         I/O         IOR, PD           X0D32         4E²         8C⁶         16B⁶         I/O         IOR, PD           X0D33         4E³         8C७         16B⁶         I/O         IOR, PD           X0D34         XL7₀ut         1K⁰         I/O         IOR, PD           X0D35         XL7₀ut         1L⁰         I/O         IOR, PD           X0D36         1M⁰         8D⁰         16B⁰         I/O         IOL, PD           X0D37         XL0¼n         1N⁰         8D¹         16B⁰         I/O         IOL, PD           X0D38         XL0¾n         10⁰         8D²         16B¹¹         I/O         IOL, PD           X0D39         XL0½n         1P⁰         8D³         16B¹¹         I/O         IOL, PD           X0D40         XL0½n         8D⁴         16B¹²         I/O         IOL, PD           X0D41         XL0½n         8D⁵         16B¹³         I/O         IOL, PD           X0D42         XL0½n         8D⁶         16B¹⁵         I/O         IOL, PD           X0D43	X0D28		4F <sup>0</sup>	8C <sup>2</sup>	16B <sup>2</sup>		I/O	IOR, PD
X0D31         4F³         8C⁵         16B⁵         I/O         IOR, PD           X0D32         4E²         8C⁶         16B⁶         I/O         IOR, PD           X0D33         4E³         8C⁶         16B⁶         I/O         IOR, PD           X0D34         XL7₀ut         1K⁰         I/O         IOR, PD           X0D35         XL7₀ut         1L⁰         I/O         IOR, PD           X0D36         1M⁰         8D⁰         16B⁰         I/O         IOL, PD           X0D37         XL0¼n         1N⁰         8D¹         16B⁰         I/O         IOL, PD           X0D38         XL0₃n         10⁰         8D²         16B¹¹         I/O         IOL, PD           X0D39         XL0₃n         1P⁰         8D³         16B¹¹         I/O         IOL, PD           X0D40         XL0₃n         8D⁴         16B¹²         I/O         IOL, PD           X0D41         XL0₀n         8D⁵         16B¹³         I/O         IOL, PD           X0D42         XL0₀n         8D⁶         16B¹⁴         I/O         IOL, PD           X0D43         XL0₀nt         8D⁶         16B¹⁵         I/O         IOL, PD           X	X0D29		4F <sup>1</sup>	8C <sup>3</sup>	16B <sup>3</sup>		I/O	IOR, PD
X0D32         4E²         8C²         16B²         I/O         IOR, PD           X0D33         4E³         8C²         16B²         I/O         IOR, PD           X0D34         XL7¹ut         1K⁰         I/O         IOR, PD           X0D35         XL7²out         1L⁰         I/O         IOR, PD           X0D36         1M⁰         8D⁰         16B²         I/O         IOL, PD           X0D37         XL0⁴n         1N⁰         8D¹         16B²         I/O         IOL, PD           X0D38         XL0³n         10⁰         8D²         16B¹⁰         I/O         IOL, PD           X0D39         XL0²n         1P⁰         8D³         16B¹¹         I/O         IOL, PD           X0D40         XL0¹n         8D⁴         16B¹²         I/O         IOL, PD           X0D41         XL0₀n         8D⁵         16B¹³         I/O         IOL, PD           X0D42         XL0₀n         8D⁶         16B¹⁴         I/O         IOL, PD           X0D43         XL0¹n         8D²         16B¹⁵         I/O         IOL, PD           X0D49         XL5¹n         32A⁰         I/O         IOR, PD           X0D50         <	X0D30		4F <sup>2</sup>	8C <sup>4</sup>	16B <sup>4</sup>		I/O	IOR, PD
X0D33         4E³         8C²         16B²         I/O         IOR, PD           X0D34         XL7¹ <sub>out</sub> 1K⁰         I/O         IOR, PD           X0D35         XL7² <sub>out</sub> 1L⁰         I/O         IOR, PD           X0D36         1M⁰         8D⁰         16B³         I/O         IOL, PD           X0D37         XL0¾         1N⁰         8D¹         16B³         I/O         IOL, PD           X0D38         XL0¾         10⁰         8D²         16B¹⁰         I/O         IOL, PD           X0D39         XL0¾         1P⁰         8D³         16B¹¹         I/O         IOL, PD           X0D40         XL0¾         8D⁴         16B¹²         I/O         IOL, PD           X0D41         XL0¾         8D⁵         16B¹³         I/O         IOL, PD           X0D42         XL0¾         8D⁶         16B¹⁴         I/O         IOL, PD           X0D43         XL0¾         8D²         16B¹⁵         I/O         IOL, PD           X0D49         XL5¾         32A⁰         I/O         IOR, PD           X0D50         XL5¾         32A⁰         I/O         IOR, PD	X0D31		4F <sup>3</sup>	8C <sup>5</sup>	16B <sup>5</sup>		I/O	IOR, PD
X0D34         XL70ut         1K0         I/O         IOR, PD           X0D35         XL70ut         1L0         I/O         IOR, PD           X0D36         1M0         8D0         1688         I/O         IOL, PD           X0D37         XL04n         1N0         8D1         1689         I/O         IOL, PD           X0D38         XL03n         100         8D2         16810         I/O         IOL, PD           X0D39         XL02n         1P0         8D3         16811         I/O         IOL, PD           X0D40         XL0in         8D4         16812         I/O         IOL, PD           X0D41         XL0in         8D5         16813         I/O         IOL, PD           X0D42         XL0out         8D6         16814         I/O         IOL, PD           X0D43         XL0out         8D7         16815         I/O         IOL, PD           X0D49         XL5in         32A0         I/O         IOR, PD           X0D50         XL5in         32A1         I/O         IOR, PD	X0D32		4E <sup>2</sup>	8C <sup>6</sup>	16B <sup>6</sup>		I/O	IOR, PD
X0D35         XL720tt         1L0         I/O         IOR, PD           X0D36         1M0         8D0         1688         I/O         IOL, PD           X0D37         XL0410         1N0         8D1         1689         I/O         IOL, PD           X0D38         XL0310         100         8D2         16810         I/O         IOL, PD           X0D39         XL0110         1P0         8D3         16811         I/O         IOL, PD           X0D40         XL0110         8D4         16812         I/O         IOL, PD           X0D41         XL01000         8D5         16813         I/O         IOL, PD           X0D42         XL00000         8D6         16814         I/O         IOL, PD           X0D43         XL00000         8D7         16815         I/O         IOL, PD           X0D49         XL510000         32A0         I/O         IOR, PD           X0D50         XL531000         32A1         I/O         IOR, PD	X0D33		4E <sup>3</sup>	8C <sup>7</sup>	16B <sup>7</sup>		I/O	IOR, PD
X0D36         1M0         8D0         16B8         I/O         IOL, PD           X0D37         XL0in 1N0         1N0         8D1 16B9         I/O IOL, PD           X0D38         XL0in 1O0         8D2 16B10         I/O IOL, PD           X0D39         XL0in 1P0         8D3 16B11         I/O IOL, PD           X0D40         XL0in 8D4 16B12         I/O IOL, PD           X0D41         XL0in 8D5 16B13         I/O IOL, PD           X0D42         XL0out 8D6 16B14         I/O IOL, PD           X0D43         XL0iut 8D7 16B15         I/O IOL, PD           X0D49         XL5in 32A0         I/O IOR, PD           X0D50         XL5in 32A1         I/O IOR, PD	X0D34	XL7 <sup>1</sup> 1	Κ <sup>0</sup>				I/O	IOR, PD
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	X0D35	XL7 <sup>2</sup> <sub>out</sub> 1	L <sup>0</sup>				I/O	IOR, PD
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	X0D36	1	M <sup>0</sup>	8D <sup>0</sup>	16B <sup>8</sup>		I/O	IOL, PD
XOD39         XLO <sub>in</sub> <sup>2</sup> 1P <sup>0</sup> 8D <sup>3</sup> 16B <sup>11</sup> I/O         IOL, PD           XOD40         XLO <sub>in</sub> <sup>1</sup> 8D <sup>4</sup> 16B <sup>12</sup> I/O         IOL, PD           XOD41         XLO <sub>in</sub> <sup>0</sup> 8D <sup>5</sup> 16B <sup>13</sup> I/O         IOL, PD           XOD42         XLO <sub>out</sub> <sup>0</sup> 8D <sup>6</sup> 16B <sup>14</sup> I/O         IOL, PD           XOD43         XLO <sub>out</sub> <sup>1</sup> 8D <sup>7</sup> 16B <sup>15</sup> I/O         IOL, PD           XOD49         XLS <sub>in</sub> <sup>1</sup> 32A <sup>0</sup> I/O         IOR, PD           XOD50         XLS <sub>in</sub> <sup>3</sup> 32A <sup>1</sup> I/O         IOR, PD	X0D37	XL0 <sup>4</sup> 1	N <sup>0</sup>	8D1	16B <sup>9</sup>		I/O	IOL, PD
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	X0D38	XL0 <sup>3</sup> 1	O <sup>0</sup>	8D <sup>2</sup>	16B <sup>10</sup>		I/O	IOL, PD
X0D41         XL0 <sub>in</sub> <sup>in</sup> 8D <sup>5</sup> 16B <sup>13</sup> I/O IOL, PD           X0D42         XL0 <sub>out</sub> <sup>out</sup> 8D <sup>6</sup> 16B <sup>14</sup> I/O IOL, PD           X0D43         XL0 <sub>out</sub> <sup>in</sup> 8D <sup>7</sup> 16B <sup>15</sup> I/O IOL, PD           X0D49         XL5 <sub>in</sub> <sup>in</sup> 32A <sup>0</sup> I/O IOR, PD           X0D50         XL5 <sub>in</sub> <sup>3</sup> 32A <sup>1</sup> I/O IOR, PD	X0D39		P <sup>0</sup>	8D <sup>3</sup>	16B <sup>11</sup>		I/O	IOL, PD
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	X0D40			8D <sup>4</sup>	16B <sup>12</sup>		I/O	IOL, PD
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	X0D41			8D <sup>5</sup>	16B <sup>13</sup>		I/O	IOL, PD
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	X0D42			8D <sup>6</sup>	16B <sup>14</sup>		I/O	IOL, PD
X0D49         XL5 <sup>4</sup> <sub>in</sub> 32A <sup>0</sup> I/O         IOR, PD           X0D50         XL5 <sup>3</sup> <sub>in</sub> 32A <sup>1</sup> I/O         IOR, PD	X0D43			8D <sup>7</sup>	16B <sup>15</sup>		I/O	IOL, PD
X0D50 XL5 <sup>3</sup> <sub>in</sub> 32A <sup>1</sup> I/O IOR, PD	X0D49					32A <sup>0</sup>	I/O	IOR, PD
	X0D50					32A <sup>1</sup>	I/O	IOR, PD
	X0D51					32A <sup>2</sup>	I/O	IOR, PD

(continued)



Signal	Function						Type	Properties
X0D52	XL5 <sup>1</sup>					32A <sup>3</sup>	1/0	IOR, PD
X0D53	XL5 <sup>0</sup> <sub>in</sub>					32A <sup>4</sup>	I/O	IOR, PD
X0D54	XL5 <sub>out</sub>					32A <sup>5</sup>	I/O	IOR, PD
X0D55	XL5 <sup>1</sup>					32A <sup>6</sup>	I/O	IOR, PD
X0D56	XL5 <sup>2</sup> <sub>out</sub>					32A <sup>7</sup>	I/O	IOR, PD
X0D57	XL5 <sup>3</sup> out					32A <sup>8</sup>	I/O	IOR, PD
X0D58	XL5 <sup>4</sup> <sub>out</sub>					32A <sup>9</sup>	I/O	IOR, PD
X0D61	XL6 <sup>4</sup> <sub>in</sub>					32A <sup>10</sup>	I/O	IOR, PD
X0D62	XL6 <sup>3</sup>					32A <sup>11</sup>	I/O	IOR, PD
X0D63	XL6 <sup>2</sup>					32A <sup>12</sup>	I/O	IOR, PD
X0D64	XL6 <sup>1</sup>					32A <sup>13</sup>	I/O	IOR, PD
X0D65	XL6 <sup>0</sup> <sub>in</sub>					32A <sup>14</sup>	I/O	IOR, PD
X0D66	XL6 <sub>out</sub>					32A <sup>15</sup>	I/O	IOR, PD
X0D67	XL6 <sub>out</sub>					32A <sup>16</sup>	I/O	IOR, PD
X0D68	XL6 <sup>2</sup> <sub>out</sub>					32A <sup>17</sup>	I/O	IOR, PD
X0D69	XL6 <sup>3</sup> out					32A <sup>18</sup>	I/O	IOR, PD
X0D70	XL64 <sub>out</sub>					32A <sup>19</sup>	I/O	IOR, PD
X1D00	XL7 <sup>2</sup>	1A <sup>0</sup>					I/O	IOR, PD
X1D01	XL7 <sup>1</sup>	1B <sup>0</sup>					I/O	IOR, PD
X1D02	XL4 <sup>0</sup> <sub>in</sub>		4A <sup>0</sup>	8A <sup>0</sup>	16A <sup>0</sup>	32A <sup>20</sup>	I/O	IOR, PD
X1D03	XL4 <sub>out</sub>		4A <sup>1</sup>	8A <sup>1</sup>	16A <sup>1</sup>	32A <sup>21</sup>	I/O	IOR, PD
X1D04	XL4 <sup>1</sup> <sub>out</sub>		4B <sup>0</sup>	8A <sup>2</sup>	16A <sup>2</sup>	32A <sup>22</sup>	I/O	IOR, PD
X1D05	XL4 <sup>2</sup> <sub>out</sub>		4B <sup>1</sup>	8A <sup>3</sup>	16A <sup>3</sup>	32A <sup>23</sup>	I/O	IOR, PD
X1D06	XL4 <sup>3</sup> <sub>out</sub>		4B <sup>2</sup>	8A <sup>4</sup>	16A <sup>4</sup>	32A <sup>24</sup>	I/O	IOR, PD
X1D07	XL4 <sup>4</sup> <sub>out</sub>		4B <sup>3</sup>	8A <sup>5</sup>	16A <sup>5</sup>	32A <sup>25</sup>	I/O	IOR, PD
X1D08	XL7 <sup>4</sup> <sub>in</sub>		4A <sup>2</sup>	8A <sup>6</sup>	16A <sup>6</sup>	32A <sup>26</sup>	I/O	IOR, PD
X1D09	XL7 <sup>3</sup>		4A <sup>3</sup>	8A <sup>7</sup>	16A <sup>7</sup>	32A <sup>27</sup>	I/O	IOR, PD
X1D10		1C <sup>0</sup>					I/O	IOT, PD
XIDII		1D <sup>0</sup>					I/O	IOT, PD
X1D12		1E <sup>0</sup>					I/O	IOL, PD
X1D13		1F <sup>0</sup>					I/O	IOL, PD
X1D14			4C <sup>0</sup>	8B <sup>0</sup>	16A <sup>8</sup>	32A <sup>28</sup>	I/O	IOR, PD
X1D15			4C <sup>1</sup>	8B <sup>1</sup>	16A <sup>9</sup>	32A <sup>29</sup>	I/O	IOR, PD
X1D16	XL3 <sup>1</sup>		4D <sup>0</sup>	8B <sup>2</sup>	16A <sup>10</sup>		I/O	IOL, PD
XID17	XL3 <sup>0</sup> <sub>in</sub>		4D <sup>1</sup>	8B <sup>3</sup>	16A <sup>11</sup>		I/O	IOL, PD
X1D18	XL3 <sub>out</sub>		4D <sup>2</sup>	8B <sup>4</sup>	16A <sup>12</sup>		I/O	IOL, PD
X1D19	XL3 <sup>1</sup> <sub>out</sub>		4D <sup>3</sup>	8B <sup>5</sup>	16A <sup>13</sup>		I/O	IOL, PD
X1D20			4C <sup>2</sup>	8B <sup>6</sup>	16A <sup>14</sup>	32A <sup>30</sup>	I/O	IOR, PD
X1D21			4C <sup>3</sup>	8B <sup>7</sup>	16A <sup>15</sup>	32A <sup>31</sup>	I/O	IOR, PD
X1D22	- out	1G <sup>0</sup>					I/O	IOL, PD
X1D23		1H <sup>0</sup>					I/O	IOL, PD
X1D24		110					I/O	IOR, PD
X1D25		1J <sup>0</sup>					I/O	IOR, PD

(continued)



Signal	Function						Type	Properties
X1D26			4E <sup>0</sup>	8C <sup>0</sup>	16B <sup>0</sup>		I/O	IOT, PD
X1D27			4E <sup>1</sup>	8C <sup>1</sup>	16B <sup>1</sup>		I/O	IOT, PD
X1D28			4F <sup>0</sup>	8C <sup>2</sup>	16B <sup>2</sup>		I/O	IOT, PD
X1D29			4F <sup>1</sup>	8C <sup>3</sup>	16B <sup>3</sup>		I/O	IOT, PD
X1D30			4F <sup>2</sup>	8C <sup>4</sup>	16B <sup>4</sup>		I/O	IOT, PD
X1D31			4F <sup>3</sup>	8C <sup>5</sup>	16B <sup>5</sup>		I/O	IOT, PD
X1D32			4E <sup>2</sup>	8C <sup>6</sup>	16B <sup>6</sup>		I/O	IOT, PD
X1D33			4E <sup>3</sup>	8C <sup>7</sup>	16B <sup>7</sup>		I/O	IOT, PD
X1D34	XL0 <sub>out</sub>	1K <sup>0</sup>					I/O	IOL, PD
X1D35	XL0 <sub>out</sub>	1L <sup>0</sup>					I/O	IOL, PD
X1D36	XL0 <sub>out</sub>	1M <sup>0</sup>		8D <sup>0</sup>	16B <sup>8</sup>		I/O	IOL, PD
X1D37	XL3 <sup>4</sup> <sub>in</sub>	1N <sup>0</sup>		8D1	16B <sup>9</sup>		I/O	IOL, PD
X1D38	XL3 <sup>3</sup>	10 <sup>0</sup>		8D <sup>2</sup>	16B <sup>10</sup>		I/O	IOL, PD
X1D39	XL3 <sup>2</sup> <sub>in</sub>	1P <sup>0</sup>		8D <sup>3</sup>	16B <sup>11</sup>		I/O	IOL, PD
X1D40				8D <sup>4</sup>	16B <sup>12</sup>		I/O	IOT, PD
X1D41				8D <sup>5</sup>	16B <sup>13</sup>		I/O	IOT, PD
X1D42				8D <sup>6</sup>	16B <sup>14</sup>		I/O	IOT, PD
X1D43				8D <sup>7</sup>	16B <sup>15</sup>		I/O	IOT, PD
X1D49	XL1 <sup>4</sup> <sub>in</sub>					32A <sup>0</sup>	I/O	IOL, PD
X1D50	XL1 <sup>3</sup>					32A <sup>1</sup>	I/O	IOL, PD
X1D51	XL1 <sup>2</sup>					32A <sup>2</sup>	I/O	IOL, PD
X1D52	XL1 in					32A <sup>3</sup>	I/O	IOL, PD
X1D53	XL1 <sup>0</sup>					32A <sup>4</sup>	I/O	IOL, PD
X1D54	XL1 <sub>out</sub>					32A <sup>5</sup>	I/O	IOL, PD
X1D55	XL1 lout					32A <sup>6</sup>	I/O	IOL, PD
X1D56	XL12 <sub>out</sub>					32A <sup>7</sup>	I/O	IOL, PD
X1D57	XL13 <sub>out</sub>					32A <sup>8</sup>	I/O	IOL, PD
X1D58	XL1 <sup>4</sup> <sub>out</sub>					32A <sup>9</sup>	I/O	IOL, PD
X1D61	XL2 <sup>4</sup> <sub>in</sub>					32A <sup>10</sup>	I/O	IOL, PD
X1D62	XL2 <sup>3</sup>					32A <sup>11</sup>	I/O	IOL, PD
X1D63	XL2 <sup>2</sup>					32A <sup>12</sup>	I/O	IOL, PD
X1D64	XL2 <sup>1</sup>					32A <sup>13</sup>	I/O	IOL, PD
X1D65	XL2 <sup>0</sup> <sub>in</sub>					32A <sup>14</sup>	I/O	IOL, PD
X1D66	XL2 <sub>out</sub>					32A <sup>15</sup>	I/O	IOL, PD
X1D67	XL2 <sup>1</sup> out					32A <sup>16</sup>	I/O	IOL, PD
X1D68	XL2 <sub>out</sub>					32A <sup>17</sup>	I/O	IOL, PD
X1D69	XL2 <sub>out</sub>					32A <sup>18</sup>	I/O	IOL, PD
X1D70	XL2 <sub>out</sub>					32A <sup>19</sup>	I/O	IOL, PD

System pins (3)									
Signal	Function	Type	Properties						
CLK	PLL reference clock	Input	IOL, PD, ST						

(continued)



Signal	Function	Type	Properties
DEBUG_N	Multi-chip debug	I/O	IOL, PU
MODE[1:0]	Boot mode select	Input	PU

# 5 Example Application Diagram

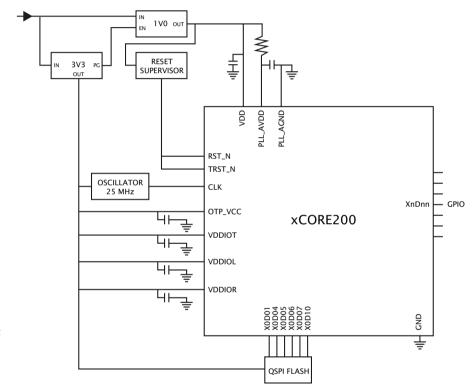


Figure 2: Simplified Reference Schematic

# 6 Product Overview

The XL216-512-FB236 is a powerful device that consists of two xCORE Tiles, each comprising a flexible logical processing cores with tightly integrated I/O and on-chip memory.

# 6.1 Logical cores

Each tile has 8 active logical cores, which issue instructions down a shared five-stage pipeline. Instructions from the active cores are issued round-robin. If up to five logical cores are active, each core is allocated a fifth of the processing cycles. If more than five logical cores are active, each core is allocated at least 1/n cycles (for n cores). Figure 3 shows the guaranteed core performance depending on the number of cores used.

Figure 3: Logical core performance

Speed	MIPS	Frequency	Minimum MIPS per core (for n cores)							
grade			1	2	3	4	5	6	7	8
10	1000 MIPS	500 MHz	100	100	100	100	100	83	71	63

There is no way that the performance of a logical core can be reduced below these predicted levels (unless *priority threads* are used: in this case the guaranteed minimum performance is computed based on the number of priority threads as defined in the architecture manual). Because cores may be delayed on I/O, however, their unused processing cycles can be taken by other cores. This means that for more than five logical cores, the performance of each core is often higher than the predicted minimum but cannot be guaranteed.

The logical cores are triggered by events instead of interrupts and run to completion. A logical core can be paused to wait for an event.

#### 6.2 xTIME scheduler

The xTIME scheduler handles the events generated by xCORE Tile resources, such as channel ends, timers and I/O pins. It ensures that all events are serviced and synchronized, without the need for an RTOS. Events that occur at the I/O pins are handled by the Hardware-Response ports and fed directly to the appropriate xCORE Tile. An xCORE Tile can also choose to wait for a specified time to elapse, or for data to become available on a channel.

Tasks do not need to be prioritised as each of them runs on their own logical xCORE. It is possible to share a set of low priority tasks on a single core using cooperative multitasking.

### 6.3 Hardware Response Ports

Hardware Response ports connect an xCORE tile to one or more physical pins and as such define the interface between hardware attached to the XL216-512-FB236, and the software running on it. A combination of 1 bit, 4 bit, 8 bit, 16 bit and 32 bit

ports are available. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.

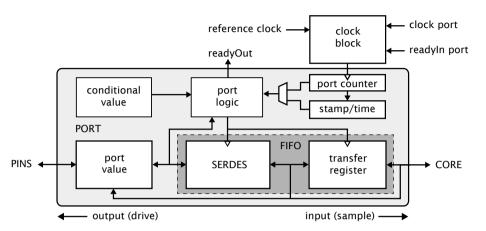


Figure 4: Port block diagram

The port logic can drive its pins high or low, or it can sample the value on its pins, optionally waiting for a particular condition. Ports are accessed using dedicated instructions that are executed in a single processor cycle. xCORE-200 IO pins can be used as *open collector* outputs, where signals are driven low if a zero is output, but left high impedance if a one is output. This option is set on a per-port basis.

Data is transferred between the pins and core using a FIFO that comprises a SERDES and transfer register, providing options for serialization and buffered data.

Each port has a 16-bit counter that can be used to control the time at which data is transferred between the port value and transfer register. The counter values can be obtained at any time to find out when data was obtained, or used to delay I/O until some time in the future. The port counter value is automatically saved as a timestamp, that can be used to provide precise control of response times.

The ports and xCONNECT links are multiplexed onto the physical pins. If an xConnect Link is enabled, the pins of the underlying ports are disabled. If a port is enabled, it overrules ports with higher widths that share the same pins. The pins on the wider port that are not shared remain available for use when the narrower port is enabled. Ports always operate at their specified width, even if they share pins with another port.

### 6.4 Clock blocks

xCORE devices include a set of programmable clocks called clock blocks that can be used to govern the rate at which ports execute. Each xCORE tile has six clock blocks: the first clock block provides the tile reference clock and runs at a default frequency of 100MHz; the remaining clock blocks can be set to run at different frequencies.

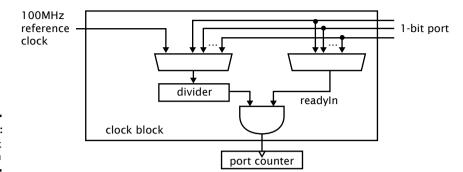


Figure 5: Clock block diagram

A clock block can use a 1-bit port as its clock source allowing external application clocks to be used to drive the input and output interfaces. xCORE-200 clock blocks optionally divide the clock input from a 1-bit port.

In many cases I/O signals are accompanied by strobing signals. The xCORE ports can input and interpret strobe (known as readyln and readyOut) signals generated by external sources, and ports can generate strobe signals to accompany output data.

On reset, each port is connected to clock block 0, which runs from the xCORE Tile reference clock.

# 6.5 Channels and Channel Ends

Logical cores communicate using point-to-point connections, formed between two channel ends. A channel-end is a resource on an xCORE tile, that is allocated by the program. Each channel-end has a unique system-wide identifier that comprises a unique number and their tile identifier. Data is transmitted to a channel-end by an output-instruction; and the other side executes an input-instruction. Data can be passed synchronously or asynchronously between the channel ends.

#### 6.6 xCONNECT Switch and Links

XMOS devices provide a scalable architecture, where multiple xCORE devices can be connected together to form one system. Each xCORE device has an xCONNECT interconnect that provides a communication infrastructure for all tasks that run on the various xCORE tiles on the system.

The interconnect relies on a collection of switches and XMOS links. Each  $\times$ CORE device has an on-chip switch that can set up circuits or route data. The switches are connected by  $\times$ Connect Links. An XMOS link provides a physical connection between two switches. The switch has a routing algorithm that supports many different topologies, including lines, meshes, trees, and hypercubes.

The links operate in either 2 wires per direction or 5 wires per direction mode, depending on the amount of bandwidth required. Circuit switched, streaming

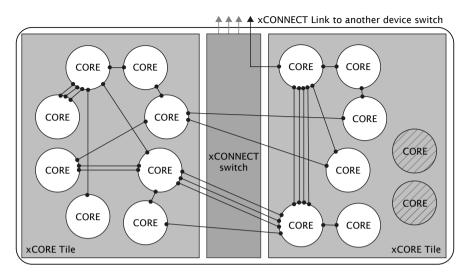


Figure 6: Switch, links and channel ends

and packet switched data can both be supported efficiently. Streams provide the fastest possible data rates between xCORE Tiles (up to 250 MBit/s), but each stream requires a single link to be reserved between switches on two tiles. All packet communications can be multiplexed onto a single link.

Information on the supported routing topologies that can be used to connect multiple devices together can be found in the XS1-L Link Performance and Design Guide, X2999.

# 7 PLL

The PLL creates a high-speed clock that is used for the switch, tile, and reference clock. The PLL multiplication value is selected through the two MODE pins, and can be changed by software to speed up the tile or use less power. The MODE pins are set as shown in Figure 7:

Figure 7: PLL multiplier values and MODE pins

Oscillator	MODE		Tile	PLL Ratio	PLL	setting	gs	
Frequency	1	0	Frequency		OD	F	R	
3.25-10 MHz	0	0	130-400 MHz	40	1	159	0	
9-25 MHz	1	1	144-400 MHz	16	1	63	0	
25-50 MHz	1	0	167-400 MHz	8	1	31	0	
50-100 MHz	0	1	196-400 MHz	4	1	15	0	

Figure 7 also lists the values of *OD*, *F* and *R*, which are the registers that define the ratio of the tile frequency to the oscillator frequency:

$$F_{core} = F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \times \frac{1}{OD+1}$$

OD, F and R must be chosen so that  $0 \le R \le 63$ ,  $0 \le F \le 4095$ ,  $0 \le OD \le 7$ , and  $260MHz \le F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \le 1.3GHz$ . The OD, F, and R values can be modified by writing to the digital node PLL configuration register.

The MODE pins must be held at a static value during and after deassertion of the system reset.

If a different tile frequency is required (eg, 500 MHz), then the PLL must be reprogrammed after boot to provide the required tile frequency. The XMOS tools perform this operation by default. Further details on configuring the clock can be found in the xCORE-200 Clock Frequency Control document.

# 8 Boot Procedure

The device is kept in reset by driving RST\_N low. When in reset, all GPIO pins have a pull-down enabled. When the device is taken out of reset by releasing RST\_N the processor starts its internal reset process. After 15-150  $\mu$ s (depending on the input clock) the processor boots.

The xCORE Tile boot procedure is illustrated in Figure 8. If bit 5 of the security register (see §9.1) is set, the device boots from OTP. To get a high value, a 3K3 pull-up resistor should be strapped onto the pin. To assure a low value, a pull-down resistor is required if other external devices are connected to this port.

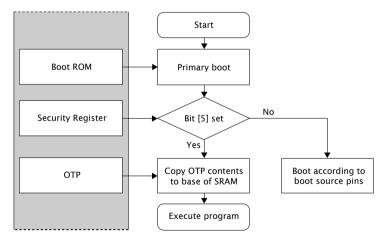


Figure 8: Boot procedure

The boot image has the following format:

▶ A 32-bit program size s in words.

VODO	006 X0D05 X0D0		T'1. 0 b	T1. 1 L	e contrate a				
X0D06	XUDUS	X0D04	Tile 0 boot	Tile 1 boot	Enabled links				
0	0	0	QSPI master	QSPI master Channel end 0					
0	0	1	SPI master Channel end 0		None				
0	1	0	SPI slave	PI slave Channel end 0 N					
0	1	1	SPI slave	SPI slave	None				
1	0	0	Channel end 0	Channel end 0	XL0 (2w)				
1	0	1	Channel end 0	Channel end 0	XL4-XL7 (5w)				
1	1	0	Channel end 0 Channel end 0		XL1, XL2, XL5,				
					and XL6 (5w)				
1	1	1	Channel end 0	Channel end 0	XI 0-XI 3 (5w)				

Figure 9: Boot source pins

- ▶ Program consisting of  $s \times 4$  bytes.
- ► A 32-bit CRC, or the value 0x0D15AB1E to indicate that no CRC check should be performed.

The program size and CRC are stored least significant byte first. The program is loaded into the lowest memory address of RAM, and the program is started from that address. The CRC is calculated over the byte stream represented by the program size and the program itself. The polynomial used is 0xEDB88320 (IEEE 802.3); the CRC register is initialized with 0xFFFFFFFF and the residue is inverted to produce the CRC.

### 8.1 Boot from OSPI master

If set to boot from QSPI master, the processor enables the six pins specified in Figure 10, and drives the SPI clock at 50 MHz (assuming a 400 MHz core clock). A READ command is issued with a 24-bit address 0x000000. The clock polarity and phase are 0 / 0.

Figure 10: QSPI pins

Pin	Signal	Description
X0D01	SS	Slave Select
X0D04X0D07	SPIO	Data
X0D10	SCLK	Clock

The xCORE Tile expects each byte to be transferred with the *least-significant nibble first*. Programmers who write bytes into an QSPI interface using the most significant nibble first may have to reverse the nibbles in each byte of the image stored in the OSPI device.

The pins used for QSPI boot are hardcoded in the boot ROM and cannot be changed. If required, an QSPI boot program can be burned into OTP that uses different pins.

### 8.2 Boot from SPI master

If set to boot from SPI master, the processor enables the four pins specified in Figure 11, and drives the SPI clock at 2.5 MHz (assuming a 400 MHz core clock). A READ command is issued with a 24-bit address  $0 \times 000000$ . The clock polarity and phase are 0 / 0.

Figure 11: SPI master pins

Pin	Signal	Description
X0D00	MISO	Master In Slave Out (Data)
X0D01	SS	Slave Select
X0D10	SCLK	Clock
X0D11	MOSI	Master Out Slave In (Data)

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. Programmers who write bytes into an SPI interface using the most significant bit first may have to reverse the bits in each byte of the image stored in the SPI device.

If a large boot image is to be read in, it is faster to first load a small boot-loader that reads the large image using a faster SPI clock, for example 50 MHz or as fast as the flash device supports.

The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

#### 8.3 Boot from SPI slave

If set to boot from SPI slave, the processor enables the three pins specified in Figure 12 and expects a boot image to be clocked in. The supported clock polarity and phase are 0/0 and 1/1.

Figure 12: SPI slave pins

Pin	Signal	Description	
X0D00	SS	Slave Select	
X0D10	SCLK	Clock	
X0D11	MOSI	Master Out Slave In (Data)	

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

#### 8.4 Boot from xConnect Link

If set to boot from an xConnect Link, the processor enables its link(s) around 2 us after the boot process starts. Enabling the Link switches off the pull-down resistors on the link, drives all the TX wires low (the initial state for the Link), and monitors the RX pins for boot-traffic; they must be low at this stage. If the internal pull-down is too weak to drain any residual charge, external pull-downs of 10K may be required on those pins.

The boot-rom on the core will then:

- 1. Allocate channel-end 0.
- 2. Input a word on channel-end 0. It will use this word as a channel to acknowledge the boot. Provide the null-channel-end 0x0000FF02 if no acknowledgment is required.
- 3. Input the boot image specified above, including the CRC.
- 4. Input an END control token.
- 5. Output an END control token to the channel-end received in step 2.
- 6. Free channel-end 0.
- 7. Jump to the loaded code.

#### 8.5 Boot from OTP

If an xCORE tile is set to use secure boot (see Figure 8), the boot image is read from address 0 of the OTP memory in the tile's security module.

This feature can be used to implement a secure bootloader which loads an encrypted image from external flash, decrypts and CRC checks it with the processor, and discontinues the boot process if the decryption or CRC check fails. XMOS provides a default secure bootloader that can be written to the OTP along with secret decryption keys.

Each tile has its own individual OTP memory, and hence some tiles can be booted from OTP while others are booted from SPI or the channel interface. This enables systems to be partially programmed, dedicating one or more tiles to perform a particular function, leaving the other tiles user-programmable.

# 8.6 Security register

The security register enables security features on the xCORE tile. The features shown in Figure 13 provide a strong level of protection and are sufficient for providing strong IP security.

# 9 Memory

#### 9.1 OTP

Each xCORE Tile integrates 8 KB one-time programmable (OTP) memory along with a security register that configures system wide security features. The OTP holds data in four sectors each containing 512 rows of 32 bits which can be used to implement secure bootloaders and store encryption keys. Data for the security register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

Feature	Bit	Description
Disable JTAG	0	The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
Disable Link access	1	Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a "secure island" with other tiles free for non-secure user application code.
Secure Boot	5	The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (see §8).
Redundant rows	7	Enables redundant rows in OTP.
Sector Lock 0	8	Disable programming of OTP sector 0.
Sector Lock 1	9	Disable programming of OTP sector 1.
Sector Lock 2	10	Disable programming of OTP sector 2.
Sector Lock 3	11	Disable programming of OTP sector 3.
OTP Master Lock	12	Disable OTP programming completely: disables updates to all sectors and security register.
Disable JTAG-OTP	13	Disable all (read & write) access from the JTAG interface to this OTP.
Disable Global Debug	14	Disables access to the DEBUG_N pin.
	2115	General purpose software accessable security register available to end-users.
	3122	General purpose user programmable JTAG UserID code extension.

Figure 13: Security register features

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through libotp and xburn.

### **9.2 SRAM**

Each xCORE Tile integrates a single 256KBSRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

# 10 JTAG

The JTAG module can be used for loading programs, boundary scan testing, incircuit source-level debugging and programming the OTP memory.

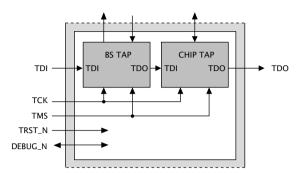


Figure 14: JTAG chain structure

The JTAG chain structure is illustrated in Figure 14. Directly after reset, two TAP controllers are present in the JTAG chain for each xCORE Tile: the boundary scan TAP and the chip TAP. The boundary scan TAP is a standard 1149.1 compliant TAP that can be used for boundary scan of the I/O pins. The chip TAP provides access into the xCORE Tile, switch and OTP for loading code and debugging.

The TRST\_N pin must be asserted low during and after power up for 100 ns. If JTAG is not required, the TRST\_N pin can be tied to ground to hold the JTAG module in reset.

The DEBUG\_N pin is used to synchronize the debugging of multiple xCORE Tiles. This pin can operate in both output and input mode. In output mode and when configured to do so, DEBUG\_N is driven low by the device when the processor hits a debug break point. Prior to this point the pin will be tri-stated. In input mode and when configured to do so, driving this pin low will put the xCORE Tile into debug mode. Software can set the behavior of the xCORE Tile based on this pin. This pin should have an external pull up of  $4K7-47K\Omega$  or left not connected in single core applications.

The JTAG device identification register can be read by using the IDCODE instruction. Its contents are specified in Figure 15.

Figure 15: IDCODE return value

	Bit3	31 Device Identification Register Bit0																														
Version Part Number M										Man	ufac	ture	r Ide	entity	/			1														
ľ	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	1	1	0	0	0	1	1	0	0	1	1
		0 0 0 0 6 6 3 3																														

The JTAG usercode register can be read by using the USERCODE instruction. Its contents are specified in Figure 16. The OTP User ID field is read from bits [22:31] of the security register on xCORE Tile 0, see §9.1 (all zero on unprogrammed devices).

Figure 16: USERCODE return value

E	Bit31													ı	Jser	code	Reg	giste	r												В	it0
	OTP User ID Unused Silicon Revision																															
(	) (	)	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0				(	)			(	)			- 2	2			- 1	8			(	)			(	)				)	

# 11 Board Integration

The device has the following power supply pins:

- ▶ VDD pins for the xCORE Tile
- ▶ VDDIO pins for the I/O lines. Separate I/O supplies are provided for the left, top, and right side of the package; different I/O voltages may be supplied on those. The signal description (Section 4) specifies which I/O is powered from which power-supply
- ▶ PLL\_AVDD pins for the PLL
- ▶ OTP\_VCC pins for the OTP

Several pins of each type are provided to minimize the effect of inductance within the package, all of which must be connected. The power supplies must be brought up monotonically and input voltages must not exceed specification at any time.

The VDD supply must ramp from 0 V to its final value within 10 ms to ensure correct startup.

The VDDIO and OTP\_VCC supply must ramp to its final value before VDD reaches 0.4 V.

The PLLVDD supply should be separated from the other noisier supplies on the board. The PLL requires a very clean power supply, and a low pass filter (for example, a  $4.7\,\Omega$  resistor and  $100\,\text{nF}$  multi-layer ceramic capacitor) is recommended on this pin.

The following ground pins are provided:

- PLL\_AGND for PLL\_AVDD
- ► GND for all other supplies

All ground pins must be connected directly to the board ground.

The VDD and VDDIO supplies should be decoupled close to the chip by several 100 nF low inductance multi-layer ceramic capacitors between the supplies and GND (for example, 4x100nF 0402 low inductance MLCCs per supply rail). The ground side of the decoupling capacitors should have as short a path back to the

GND pins as possible. A bulk decoupling capacitor of at least 10 uF should be placed on each of these supplies.

RST\_N is an active-low asynchronous-assertion global reset signal. Following a reset, the PLL re-establishes lock after which the device boots up according to the boot mode (*see* §8). RST\_N and must be asserted low during and after power up for 100 ns.

# 11.1 Land patterns and solder stencils

The land pattern recommendations in this document are based on a RoHS compliant process and derived, where possible, from the nominal *Generic Requirements for Surface Mount Design and Land Pattern Standards* IPC-7351B specifications. This standard aims to achieve desired targets of heel, toe and side fillets for solder-joints.

Solder paste and ground via recommendations are based on our engineering and development kit board production. They have been found to work and optimized as appropriate to achieve a high yield. The size, type and number of vias used in the center pad affects how much solder wicks down the vias during reflow. This in turn, along with solder paster coverage, affects the final assembled package height. These factors should be taken into account during design and manufacturing of the PCR.

The following land patterns and solder paste contains recommendations. Final land pattern and solder paste decisions are the responsibility of the customer. These should be tuned during manufacture to suit the manufacturing process.

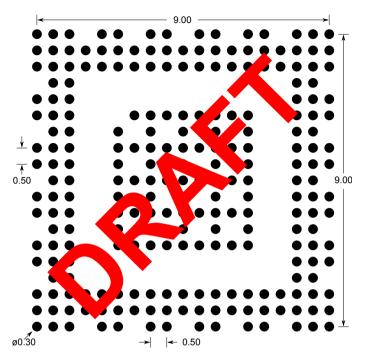
The package is a 236 pin Ball Grid Array package on a 0.5mm pitch with 0.3mm balls. An example land pattern is shown in Figure 17.

The landing pads for the balls should have a 0.25mm diameter, with a 0.275mm opening in the soldermask. Alternatively, if larger pads are desired (for example to include a standard HDI in-pad via), then the soldermask should constrain those pads to be 0.25mm in diameter (Solder Mask Defined pads). Contact your PCB manufacturing and assembly facilities for recommendations for your particular design.

The missing balls in the outer rows can be used to route the first inner row out over the top layer. The missing balls in the center can be used for through-hole ground vias. The missing rows four and five can be used for through-hole VDD vias if required.

#### 11.2 Ground and Thermal Vias

Vias next to each ground ball into the ground plane of the PCB are recommended for a low inductance ground connection and good thermal performance. Vias with with a 0.6mm diameter annular ring and a 0.3mm drill would be suitable.



**Figure 17:** Example land pattern

# 11.3 Moisture Sensitivity

XMOS devices are, like all semiconductor devices, susceptible to moisture absorption. When removed from the sealed packaging, the devices slowly absorb moisture from the surrounding environment. If the level of moisture present in the device is too high during reflow, damage can occur due to the increased internal vapour pressure of moisture. Example damage can include bond wire damage, die lifting, internal or external package cracks and/or delamination.

All XMOS devices are Moisture Sensitivity Level (MSL) 3 - devices have a shelf life of 168 hours between removal from the packaging and reflow, provided they are stored below 30C and 60% RH. If devices have exceeded these values or an included moisture indicator card shows excessive levels of moisture, then the parts should be baked as appropriate before use. This is based on information from *Joint IPC/JEDEC Standard For Moisture/Reflow Sensitivity Classification For Nonhermetic Solid State Surface-Mount Devices* J-STD-020 Revision D.

# 12 DC and Switching Characteristics

# 12.1 Operating Conditions

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
VDD	Tile DC supply voltage	0.95	1.00	1.05	V	
VDDIOL	I/O supply voltage	3.135	3.30	3.465	V	
VDDIOR	I/O supply voltage	3.135	3.30	3.465	V	
VDDIOT 3v3	I/O supply voltage	3.135	3.30	3.465	V	
VDDIOT 2v5	I/O supply voltage	2.375	2.50	2.625	V	
PLL_AVDD	PLL analog supply	0.95	1.00	1.05	V	
Cl	xCORE Tile I/O load capacitance			25	pF	
Та	Ambient operating temperature (Commercial)	0		70	°C	
	Ambient operating temperature (Industrial)	-40		85	°C	
Tj	Junction temperature			125	°C	
Tstg	Storage temperature	-65		150	°C	

Figure 18: Operating conditions

# 12.2 DC Characteristics

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
V(IH)	Input high voltage	2.00		3.60	V	Α
V(IL)	Input low voltage	-0.30		0.70	V	Α
V(OH)	Output high voltage	2.20			V	B, C
V(OL)	Output low voltage			0.40	V	B, C
R(PU)	Pull-up resistance		35K		Ω	D
R(PD)	Pull-down resistance		35K		Ω	D

Figure 19: DC characteristics

- A All pins except power supply pins.
- B All general-purpose I/Os are nominal 4 mA.
- C Measured with 4 mA drivers sourcing 4 mA, 8 mA drivers sourcing 8 mA.
- D Used to guarantee logic state for an I/O when high impedance. The internal pull-ups/pull-downs should not be used to pull external circuitry.

# 12.3 ESD Stress Voltage

Figure 20: ESD stress voltage

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
HBM	Human body model	-2.00		2.00	KV	
CDM	Charged Device Model	-500		500	٧	

### 12.4 Reset Timing

Figure 21: Reset timing

Symbol	Parameters	MIN	TYP	MAX	UNITS	Notes
T(RST)	Reset pulse width	5			μs	
T(INIT)	Initialization time			150	μs	Α

A Shows the time taken to start booting after RST\_N has gone high.

# 12.5 Power Consumption

Figure 22: xCORE Tile currents

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
I(DDCQ)	Quiescent VDD current		45		mA	A, B, C
PD	Tile power dissipation		325		µW/MIPS	A, D, E, F
IDD	Active VDD current		570	700	mA	A, G
I(ADDPLL)	PLL_AVDD current		5	7	mA	Н

- A Use for budgetary purposes only.
- B Assumes typical tile and I/O voltages with no switching activity.
- C Includes PLL current.
- D Assumes typical tile and I/O voltages with nominal switching activity.
- E Assumes 1 MHz = 1 MIPS.
- F PD(TYP) value is the usage power consumption under typical operating conditions.
- G Measurement conditions: VDD = 1.0 V, VDDIO = 3.3 V, 25 °C, 500 MHz, average device resource usage.
- H PLL\_AVDD = 1.0 V



The tile power consumption of the device is highly application dependent and should be used for budgetary purposes only.

More detailed power analysis can be found in the XS1-L Power Consumption document,

### 12.6 Clock

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
f	Frequency	3.25	25	100	MHz	
SR	Slew rate	0.10			V/ns	
TJ(LT)	Long term jitter (pk-pk)			2	%	Α
f(MAX)	Processor clock frequency ()			400	MHz	В
I (IVIAAA)	Processor clock frequency			500	MHz	В

Figure 23: Clock

Further details can be found in the XS1-L Clock Frequency Control document,

A Percentage of CLK period.

B Assumes typical tile and I/O voltages with nominal activity.

# 12.7 xCORE Tile I/O AC Characteristics

Figure 24: I/O AC characteristics

Symbol	Parameter		TYP	MAX	UNITS	Notes
T(XOVALID)	Input data valid window	8			ns	
T(XOINVALID)	Output data invalid window	9			ns	
T(XIFMAX)	Rate at which data can be sampled with respect to an external clock			60	MHz	

The input valid window parameter relates to the capability of the device to capture data input to the chip with respect to an external clock source. It is calculated as the sum of the input setup time and input hold time with respect to the external clock as measured at the pins. The output invalid window specifies the time for which an output is invalid with respect to the external clock. Note that these parameters are specified as a window rather than absolute numbers since the device provides functionality to delay the incoming clock with respect to the incoming data.

Information on interfacing to high-speed synchronous interfaces can be found in the XS1 Port I/O Timing document, X5821.

### 12.8 xConnect Link Performance

Figure 25: Link performance

Symbol	Parameter		TYP	MAX	UNITS	Notes
B(2blinkP)	2b link bandwidth (packetized)			87	MBit/s	A, B
B(5blinkP)	5b link bandwidth (packetized)			217	MBit/s	A, B
B(2blinkS)	2b link bandwidth (streaming)			100	MBit/s	В
B(5blinkS)	5b link bandwidth (streaming)			250	MBit/s	В

A Assumes 32-byte packet in 3-byte header mode. Actual performance depends on size of the header and payload.

The asynchronous nature of links means that the relative phasing of CLK clocks is not important in a multi-clock system, providing each meets the required stability criteria.

### 12.9 JTAG Timing

Symbol	Parameter	MIN	TYP	MAX	UNITS	Notes
f(TCK_D)	TCK frequency (debug)			18	MHz	
f(TCK_B)	TCK frequency (boundary scan)			10	MHz	
T(SETUP)	TDO to TCK setup time	5			ns	Α
T(HOLD)	TDO to TCK hold time	5			ns	Α
T(DELAY)	TCK to output delay			15	ns	В

Figure 26: JTAG timing

All JTAG operations are synchronous to TCK apart from the global asynchronous reset TRST\_N.

B 7.5 ns symbol time.

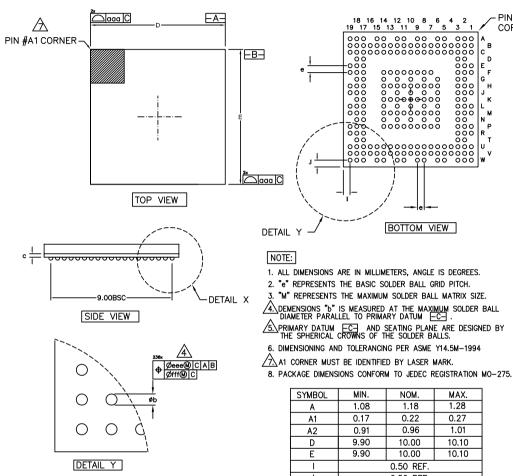
A Timing applies to TMS and TDI inputs.

B Timing applies to TDO output from negative edge of TCK.

PIN #A1

CORNER

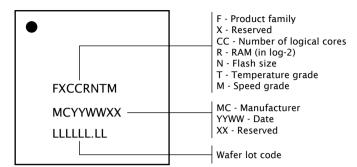
# 13 Package Information



			//ccc C
4		A2	1
	()	1	Î
DETAIL X	SEATING	IC PLANE S	-c-

SYMBOL	MIN.	NOM.	MAX.
Α	1.08	1.18	1.28
A1	0.17	0.22	0.27
A2	0.91	0.96	1.01
D	9.90	10.00	10.10
E	9.90	10.00	10.10
1	0.50 REF.		
J	0.50 REF.		
М	19x19	<depopulat< td=""><td>ED&gt;</td></depopulat<>	ED>
aaa			0.15
ссс			0.10
ddd			0.08
eee			0.15
fff			0.05
b	0.25	0.30	0.35
е	0.50 BSC.		
С	0.26 REF.		

# 13.1 Part Marking



**Figure 27:** Part marking scheme

# 14 Ordering Information

Figure 28: Orderable part numbers

Product Code	Marking	Qualification	Speed Grade
XL216-512-FB236-C20	L11690C20	Commercial	1000 MIPS
XL216-512-FB236-I20	L11690I20	Industrial	1000 MIPS

# **Appendices**

# A Configuration of the XL216-512-FB236

The device is configured through banks of registers, as shown in Figure 29.

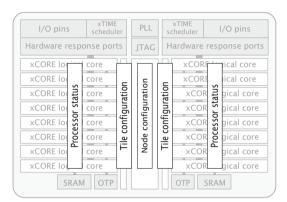


Figure 29: Registers

The following communication sequences specify how to access those registers. Any messages transmitted contain the most significant 24 bits of the channel-end to which a response is to be sent. This comprises the node-identifier and the channel number within the node. If no response is required on a write operation, supply 24-bits with the last 8-bits set, which suppresses the reply message. Any multi-byte data is sent most significant byte first.

### A.1 Accessing a processor status register

The processor status registers are accessed directly from the processor instruction set. The instructions GETPS and SETPS read and write a word. The register number should be translated into a processor-status resource identifier by shifting the register number left 8 places, and ORing it with 0x0C. Alternatively, the functions getps(reg) and setps(reg,value) can be used from XC.

### A.2 Accessing an xCORE Tile configuration register

xCORE Tile configuration registers can be accessed through the interconnect using the functions write\_tile\_config\_reg(tileref, ...) and read\_tile\_config\_reg(tile \( \to \) ref, ...), where tileref is the name of the xCORE Tile, e.g. tile[1]. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the xCORE tile configuration registers. The destination of the channel-end should be set to OxnonnC2OC where nnnnn is the tile-identifier.

A write message comprises the following:

control-token	24-bit response	16-bit	32-bit	control-token
192	channel-end identifier	register number	data	1

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

control-token	24-bit response	16-bit	control-token
193	channel-end identifier	register number	1

The response to the read message comprises either control token 3, 32-bit of data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).

# A.3 Accessing node configuration

Node configuration registers can be accessed through the interconnect using the functions write\_node\_config\_reg(device, ...) and read\_node\_config\_reg(device, ...), where device is the name of the node. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the node configuration registers. The destination of the channel-end should be set to OxnnnnC30C where nnnn is the node-identifier.

A write message comprises the following:

control-token	24-bit response	16-bit	32-bit	control-token
192	channel-end identifier	register number	data	1

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

control-token	24-bit response	16-bit	control-token
193	channel-end identifier	register number	1

The response to a read message comprises either control token 3, 32-bit of data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).

# **B** Processor Status Configuration

The processor status control registers can be accessed directly by the processor using processor status reads and writes (use getps(reg) and setps(reg,value) for reads and writes).

Number	Perm	Description
0x00	RW	RAM base address
0x01	RW	Vector base address
0x02	RW	xCORE Tile control
0x03	RO	xCORE Tile boot status
0x05	RW	Security configuration
0x06	RW	Ring Oscillator Control
0x07	RO	Ring Oscillator Value
0x08	RO	Ring Oscillator Value
0x09	RO	Ring Oscillator Value
0x0A	RO	Ring Oscillator Value
0x0C	RO	RAM size
0x10	DRW	Debug SSR
0x11	DRW	Debug SPC
0x12	DRW	Debug SSP
0x13	DRW	DGETREG operand 1
0x14	DRW	DGETREG operand 2
0x15	DRW	Debug interrupt type
0x16	DRW	Debug interrupt data
0x18	DRW	Debug core control
0x20 0x27	DRW	Debug scratch
0x30 0x33	DRW	Instruction breakpoint address
0x40 0x43	DRW	Instruction breakpoint control
0x50 0x53	DRW	Data watchpoint address 1
0x60 0x63	DRW	Data watchpoint address 2
0x70 0x73	DRW	Data breakpoint control register
0x80 0x83	DRW	Resources breakpoint mask
0x90 0x93	DRW	Resources breakpoint value
0x9C 0x9F	DRW	Resources breakpoint control register

Figure 30: Summary

### B.1 RAM base address: 0x00

This register contains the base address of the RAM. It is initialized to 0x00040000.

0x00: RAM base address

Bits	Perm	Init	Description
31:2	RW		Most significant 16 bits of all addresses.
1:0	RO	-	Reserved

# B.2 Vector base address: 0x01

Base address of event vectors in each resource. On an interrupt or event, the 16 most significant bits of the destination address are provided by this register; the least significant 16 bits come from the event vector.

0x01: Vector base address

Bits	Perm	Init	Description
31:18	RW		The event and interrupt vectors.
17:0	RO	-	Reserved

# B.3 xCORE Tile control: 0x02

Register to control features in the xCORE tile

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:18	RW	0	RGMII TX data delay value (in PLL output cycle increments)
17:9	RW	0	RGMII TX clock divider value. TX clk rises when counter (clocked by PLL output) reaches this value and falls when counter reaches (value»1). Value programmed into this field should be actual divide value required minus 1
8	RW	0	Enable RGMII interface periph ports
7:6	RO	-	Reserved
5	RW	0	Select the dynamic mode (1) for the clock divider when the clock divider is enabled. In dynamic mode the clock divider is only activated when all active threads are paused. In static mode the clock divider is always enabled.
4	RW	0	Enable the clock divider. This divides the output of the PLL to facilitate one of the low power modes.
3:0	RO	-	Reserved

0x02: xCORE Tile control

# B.4 xCORE Tile boot status: 0x03

This read-only register describes the boot status of the xCORE tile.

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	RO		Processor number.
15:9	RO	-	Reserved
8	RO		Overwrite BOOT_MODE.
7:6	RO	-	Reserved
5	RO		Indicates if core1 has been powered off
4	RO		Cause the ROM to not poll the OTP for correct read levels
3	RO		Boot ROM boots from RAM
2	RO		Boot ROM boots from JTAG
1:0	RO		The boot PLL mode pin value.

0x03: xCORE Tile boot status

# **B.5** Security configuration: 0x05

Copy of the security register as read from OTP.

Bits	Perm	Init	Description
31	RW		Disables write permission on this register
30:15	RO	-	Reserved
14	RW		Disable access to XCore's global debug
13	RO	-	Reserved
12	RW		lock all OTP sectors
11:8	RW		lock bit for each OTP sector
7	RW		Enable OTP reduanacy
6	RO	-	Reserved
5	RW		Override boot mode and read boot image from OTP
4	RW		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	RW		Disable access to XCore's JTAG debug TAP

**0x05:** Security configuration

# **B.6** Ring Oscillator Control: 0x06

There are four free-running oscillators that clock four counters. The oscillators can be started and stopped using this register. The counters should only be read when the ring oscillator has been stopped for at least 10 core clock cycles (this can be achieved by inserting two nop instructions between the SETPS and GETPS). The counter values can be read using four subsequent registers. The ring oscillators are asynchronous to the xCORE tile clock and can be used as a source of random bits.

**0x06:** Ring Oscillator Control

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Core ring oscillator enable.
0	RW	0	Peripheral ring oscillator enable.

# B.7 Ring Oscillator Value: 0x07

This register contains the current count of the xCORE Tile Cell ring oscillator. This value is not reset on a system reset.

**0x07:** Ring Oscillator Value

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RO	0	Ring oscillator Counter data.

# **B.8** Ring Oscillator Value: 0x08

This register contains the current count of the xCORE Tile Wire ring oscillator. This value is not reset on a system reset.

0x08: Ring Oscillator Value

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RO	0	Ring oscillator Counter data.

### B.9 Ring Oscillator Value: 0x09

This register contains the current count of the Peripheral Cell ring oscillator. This value is not reset on a system reset.

**0x09:** Ring Oscillator Value

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RO	0	Ring oscillator Counter data.

## B.10 Ring Oscillator Value: 0x0A

This register contains the current count of the Peripheral Wire ring oscillator. This value is not reset on a system reset.

**0x0A:** Ring Oscillator Value

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RO	0	Ring oscillator Counter data.

#### B.11 RAM size: 0x0C

The size of the RAM in bytes

0x0C: RAM size

Bits	Perm	Init	Description
31:2	RO		Most significant 16 bits of all addresses.
1:0	RO	-	Reserved

## B.12 Debug SSR: 0x10

This register contains the value of the SSR register when the debugger was called.

Bits	Perm	Init	Description
31:11	RO	-	Reserved
10	DRW		Address space indentifier
9	DRW		Determines the issue mode (DI bit) upon Kernel Entry after Exception or Interrupt.
8	RO		Determines the issue mode (DI bit).
7	DRW		When 1 the thread is in fast mode and will continually issue.
6	DRW		When 1 the thread is paused waiting for events, a lock or another resource.
5	RO	-	Reserved
4	DRW		1 when in kernel mode.
3	DRW		1 when in an interrupt handler.
2	DRW		1 when in an event enabling sequence.
1	DRW		When 1 interrupts are enabled for the thread.
0	DRW		When 1 events are enabled for the thread.

0x10: Debug SSR

## B.13 Debug SPC: 0x11

This register contains the value of the SPC register when the debugger was called.

0x1	1:
Debug SP	C

Bits	Perm	Init	Description
31:0	DRW		Value.

## B.14 Debug SSP: 0x12

This register contains the value of the SSP register when the debugger was called.

0x12:
Debug SSP

Bits	Perm	Init	Description
31:0	DRW		Value.

## B.15 DGETREG operand 1: 0x13

The resource ID of the logical core whose state is to be read.

0x13: DGETREG operand 1

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7:0	DRW		Thread number to be read

#### B.16 DGETREG operand 2: 0x14

Register number to be read by DGETREG

**0x14:** DGETREG operand 2

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4:0	DRW		Register number to be read

## B.17 Debug interrupt type: 0x15

Register that specifies what activated the debug interrupt.

Bits	Perm	Init	Description
31:18	RO	-	Reserved
17:16	DRW		Number of the hardware breakpoint/watchpoint which caused the interrupt (always 0 for =HOST= and =DCALL=). If multiple breakpoints/watchpoints trigger at once, the lowest number is taken.
15:8	DRW		Number of thread which caused the debug interrupt (always 0 in the case of =HOST=).
7:3	RO	-	Reserved
2:0	DRW	0	Indicates the cause of the debug interrupt 1: Host initiated a debug interrupt through JTAG 2: Program executed a DCALL instruction 3: Instruction breakpoint 4: Data watch point 5: Resource watch point

0x15: Debug interrupt type

## B.18 Debug interrupt data: 0x16

On a data watchpoint, this register contains the effective address of the memory operation that triggered the debugger. On a resource watchpoint, it countains the resource identifier.

**0x16:** Debug interrupt data

Bits	Perm	Init	Description
31:0	DRW		Value.

#### B.19 Debug core control: 0x18

This register enables the debugger to temporarily disable logical cores. When returning from the debug interrupts, the cores set in this register will not execute. This enables single stepping to be implemented.

0x18: Debug core control

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7:0	DRW		1-hot vector defining which threads are stopped when not in debug mode. Every bit which is set prevents the respective thread from running.

#### B.20 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over JTAG. This is the same set of registers as the Debug Scratch registers in the xCORE tile configuration.

0x20 .. 0x27: Debug scratch

Bits	Perm	Init	Description
31:0	DRW		Value.

## B.21 Instruction breakpoint address: 0x30 .. 0x33

This register contains the address of the instruction breakpoint. If the PC matches this address, then a debug interrupt will be taken. There are four instruction breakpoints that are controlled individually.

0x30 .. 0x33: Instruction breakpoint address

Bits	Perm	Init	Description
31:0	DRW		Value.

#### B.22 Instruction breakpoint control: 0x40 .. 0x43

This register controls which logical cores may take an instruction breakpoint, and under which condition.

	Bits	Perm	Init	Description
	31:24	RO	-	Reserved
	23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
	15:2	RO	-	Reserved
	1	DRW	0	When 0 break when PC == IBREAK_ADDR. When 1 = break when PC!= IBREAK_ADDR.
Ì	0	DRW	0	When 1 the instruction breakpoint is enabled.

0x40 .. 0x43: Instruction breakpoint control

#### B.23 Data watchpoint address 1: 0x50 .. 0x53

This set of registers contains the first address for the four data watchpoints.

0x50 .. 0x53: Data watchpoint address 1

Bits	Perm	Init	Description
31:0	DRW		Value.

#### B.24 Data watchpoint address 2: 0x60 .. 0x63

This set of registers contains the second address for the four data watchpoints.

0x60 .. 0x63: Data watchpoint address 2

Bits	Perm	Init	Description
31:0	DRW		Value.

#### B.25 Data breakpoint control register: 0x70 .. 0x73

This set of registers controls each of the four data watchpoints.

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
15:3	RO	-	Reserved
2	DRW	0	When 1 the breakpoints will be be triggered on loads.
1	DRW	0	Determines the break condition: 0 = A AND B, 1 = A OR B.
0	DRW	0	When 1 the instruction breakpoint is enabled.

0x70 .. 0x73: Data breakpoint control register

#### B.26 Resources breakpoint mask: 0x80 .. 0x83

This set of registers contains the mask for the four resource watchpoints.

0x80 .. 0x83: Resources breakpoint mask

Bits	Perm	Init	Description
31:0	DRW		Value.

## B.27 Resources breakpoint value: 0x90 .. 0x93

This set of registers contains the value for the four resource watchpoints.

0x90 .. 0x93: Resources breakpoint value

Bits	Perm	Init	Description
31:0	DRW		Value.

## B.28 Resources breakpoint control register: 0x9C .. 0x9F

This set of registers controls each of the four resource watchpoints.

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
15:2	RO	-	Reserved
1	DRW	0	When 0 break when condition A is met. When 1 = break when condition B is met.
0	DRW	0	When 1 the instruction breakpoint is enabled.

0x9C .. 0x9F: Resources breakpoint control register

# C Tile Configuration

The xCORE Tile control registers can be accessed using configuration reads and writes (use write\_tile\_config\_reg(tileref, ...) and read\_tile\_config\_reg(tileref, ...) for reads and writes).

Number	Perm	Description
0x00	CRO	Device identification
0x01	CRO	xCORE Tile description 1
0x02	CRO	xCORE Tile description 2
0x04	CRW	Control PSwitch permissions to debug registers
0x05	CRW	Cause debug interrupts
0x06	CRW	xCORE Tile clock divider
0x07	CRO	Security configuration
0x20 0x27	CRW	Debug scratch
0x40	CRO	PC of logical core 0
0x41	CRO	PC of logical core 1
0x42	CRO	PC of logical core 2
0x43	CRO	PC of logical core 3
0x44	CRO	PC of logical core 4
0x45	CRO	PC of logical core 5
0x46	CRO	PC of logical core 6
0x47	CRO	PC of logical core 7
0x60	CRO	SR of logical core 0
0x61	CRO	SR of logical core 1
0x62	CRO	SR of logical core 2
0x63	CRO	SR of logical core 3
0x64	CRO	SR of logical core 4
0x65	CRO	SR of logical core 5
0x66	CRO	SR of logical core 6
0x67	CRO	SR of logical core 7

Figure 31: Summary

## C.1 Device identification: 0x00

This register identifies the xCORE Tile

Bits	Perm	Init	Description
31:24	CRO		Processor ID of this XCore.
23:16	CRO		Number of the node in which this XCore is located.
15:8	CRO		XCore revision.
7:0	CRO		XCore version.

**0x00:**Device identification

#### C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

Bits	Perm	Init	Description
31:24	CRO		Number of channel ends.
23:16	CRO		Number of the locks.
15:8	CRO		Number of synchronisers.
7:0	RO	-	Reserved

0x01: xCORE Tile description 1

#### C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

0x02: xCORE Tile description 2

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:8	CRO		Number of clock blocks.
7:0	CRO		Number of timers.

## C.4 Control PSwitch permissions to debug registers: 0x04

This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.

0x04: Control PSwitch permissions to debug registers

Bits	Perm	Init	Description
31	CRW	0	When 1 the PSwitch is restricted to RO access to all CRW registers from SSwitch, XCore(PS_DBG_Scratch) and JTAG
30:1	RO	-	Reserved
0	CRW	0	When 1 the PSwitch is restricted to RO access to all CRW registers from SSwitch

## C.5 Cause debug interrupts: 0x05

This register can be used to raise a debug interrupt in this xCORE tile.

0x05: Cause debug interrupts

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	CRW	0	1 when the processor is in debug mode.
0	CRW	0	Request a debug interrupt on the processor.

#### C.6 xCORE Tile clock divider: 0x06

This register contains the value used to divide the PLL clock to create the xCORE tile clock. The divider is enabled under control of the tile control register

0x06: xCORE Tile clock divider

Bits	Perm	Init	Description
31	CRW	0	Clock disable. Writing '1' will remove the clock to the tile.
30:16	RO	-	Reserved
15:0	CRW	0	Clock divider.

## C.7 Security configuration: 0x07

Copy of the security register as read from OTP.

Bits	Perm	Init	Description
31	CRO		Disables write permission on this register
30:15	RO	-	Reserved
14	CRO		Disable access to XCore's global debug
13	RO	-	Reserved
12	CRO		lock all OTP sectors
11:8	CRO		lock bit for each OTP sector
7	CRO		Enable OTP reduanacy
6	RO	-	Reserved
5	CRO		Override boot mode and read boot image from OTP
4	CRO		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	CRO		Disable access to XCore's ITAG debug TAP

0x07: Security configuration

## C.8 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the Debug Scratch registers in the processor status.

0x20 .. 0x27: Debug scratch

Bits	Perm	Init	Description
31:0	CRW		Value.

## C.9 PC of logical core 0: 0x40

Value of the PC of logical core 0.

**0x40:** PC of logical core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

#### C.10 PC of logical core 1: 0x41

Value of the PC of logical core 1.

0x41: PC of logical core 1

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.11 PC of logical core 2: 0x42

Value of the PC of logical core 2.

0x42: PC of logical core 2

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.12 PC of logical core 3: 0x43

Value of the PC of logical core 3.

**0x43:** PC of logical core 3

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.13 PC of logical core 4: 0x44

Value of the PC of logical core 4.

**0x44:** PC of logical core 4

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.14 PC of logical core 5: 0x45

Value of the PC of logical core 5.

**0x45:** PC of logical core 5

Bits	Perm	Init	Description
31:0	CRO		Value.

#### C.15 PC of logical core 6: 0x46

Value of the PC of logical core 6.

0x46: PC of logical core 6

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.16 PC of logical core 7: 0x47

Value of the PC of logical core 7.

**0x47:** PC of logical core 7

Bits	Perm	Init	Description
31:0	CRO		Value.

#### C.17 SR of logical core 0: 0x60

Value of the SR of logical core 0

0x60: SR of logical core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

#### C.18 SR of logical core 1: 0x61

Value of the SR of logical core 1

0x61: SR of logical core 1

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.19 SR of logical core 2: 0x62

Value of the SR of logical core 2

0x62: SR of logical core 2

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.20 SR of logical core 3: 0x63

Value of the SR of logical core 3

0x63: SR of logical core 3

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.21 SR of logical core 4: 0x64

Value of the SR of logical core 4

**0x64:** SR of logical core 4

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.22 SR of logical core 5: 0x65

Value of the SR of logical core 5

**0x65:** SR of logical core 5

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.23 SR of logical core 6: 0x66

Value of the SR of logical core 6

**0x66:** SR of logical core 6

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.24 SR of logical core 7: 0x67

Value of the SR of logical core 7

**0x67:** SR of logical core 7

Bits	Perm	Init	Description
31:0	CRO		Value.

## **D** Node Configuration

The digital node control registers can be accessed using configuration reads and writes (use write\_node\_config\_reg(device, ...) and read\_node\_config\_reg(device, ...) for reads and writes).

Number	Perm	Description
0x00	RO	Device identification
0x01	RO	System switch description
0x04	RW	Switch configuration
0x05	RW	Switch node identifier
0x06	RW	PLL settings
0x07	RW	System switch clock divider
0x08	RW	Reference clock
0x09	R	System JTAG device ID register
0x0A	R	System USERCODE register
0x0C	RW	Directions 0-7
0x0D	RW	Directions 8-15
0x10	RW	DEBUG_N configuration, tile 0
0x11	RW	DEBUG_N configuration, tile 1
0x1F	RO	Debug source
0x20 0x28	RW	Link status, direction, and network
0x40 0x47	RO	PLink status and network
0x80 0x88	RW	Link configuration and initialization
0xA0 0xA7	RW	Static link configuration

Figure 32: Summary

#### D.1 Device identification: 0x00

This register contains version and revision identifiers and the mode-pins as sampled at boot-time.

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	RO		Sampled values of BootCtl pins on Power On Reset.
15:8	RO		SSwitch revision.
7:0	RO		SSwitch version.

**0x00:**Device identification

#### D.2 System switch description: 0x01

This register specifies the number of processors and links that are connected to this switch.

0x01: System switch description

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	RO		Number of SLinks on the SSwitch.
15:8	RO		Number of processors on the SSwitch.
7:0	RO		Number of processors on the device.

#### D.3 Switch configuration: 0x04

This register enables the setting of two security modes (that disable updates to the PLL or any other registers) and the header-mode.

Bits	Perm	Init	Description
31	RW	0	0 = SSCTL registers have write access. 1 = SSCTL registers can not be written to.
30:9	RO	-	Reserved
8	RW	0	0 = PLL_CTL_REG has write access. 1 = PLL_CTL_REG can not be written to.
7:1	RO	-	Reserved
0	RW	0	0 = 2-byte headers, 1 = 1-byte headers (reset as 0).

**0x04:** Switch configuration

#### D.4 Switch node identifier: 0x05

This register contains the node identifier.

**0x05:** Switch node identifier

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	The unique ID of this node.

#### D.5 PLL settings: 0x06

An on-chip PLL multiplies the input clock up to a higher frequency clock, used to clock the I/O, processor, and switch, see Oscillator. Note: a write to this register will cause the tile to be reset.

Bits	Perm	Init	Description
31	RW		If set to 1, the chip will not be reset
30	RW		If set to 1, the chip will not wait for the PLL to re-lock. Only use this if a gradual change is made to the PLL
29	DW		If set to 1, set the PLL to be bypassed
28	DW		If set to 1, set the boot mode to boot from JTAG
27:26	RO	-	Reserved
25:23	RW		Output divider value range from 1 (8'h0) to 250 (8'hF9). P value.
22:21	RO	-	Reserved
20:8	RW		Feedback multiplication ratio, range from 1 (8'h0) to 255 (8'hFE). M value.
7	RO	-	Reserved
6:0	RW		Oscilator input divider value range from 1 (8'h0) to 32 (8'h0F).

0x06: PLL settings

## D.6 System switch clock divider: 0x07

Sets the ratio of the PLL clock and the switch clock.

0x07: System switch clock divider

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	SSwitch clock generation

#### D.7 Reference clock: 0x08

Sets the ratio of the PLL clock and the reference clock used by the node.

0x08: Reference clock

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	3	Software ref. clock divider

#### D.8 System JTAG device ID register: 0x09

**0x09:** System JTAG device ID register

Bits	Perm	Init	Description
31:28	RO		
27:12	RO		
11:1	RO		
0	RO		

#### D.9 System USERCODE register: 0x0A

0x0A: System USERCODE register

Bi	its	Perm	Init	Description
31:1	18	RO		JTAG USERCODE value programmed into OTP SR
17	<b>'</b> :0	RO		metal fixable ID code

#### D.10 Directions 0-7: 0x0C

This register contains eight directions, for packets with a mismatch in bits 7..0 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose dimension is 7.
27:24	RW	0	The direction for packets whose dimension is 6.
23:20	RW	0	The direction for packets whose dimension is 5.
19:16	RW	0	The direction for packets whose dimension is 4.
15:12	RW	0	The direction for packets whose dimension is 3.
11:8	RW	0	The direction for packets whose dimension is 2.
7:4	RW	0	The direction for packets whose dimension is 1.
3:0	RW	0	The direction for packets whose dimension is 0.

**0x0C:** Directions 0-7

#### D.11 Directions 8-15: 0x0D

This register contains eight directions, for packets with a mismatch in bits 15..8 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose dimension is F.
27:24	RW	0	The direction for packets whose dimension is E.
23:20	RW	0	The direction for packets whose dimension is D.
19:16	RW	0	The direction for packets whose dimension is C.
15:12	RW	0	The direction for packets whose dimension is B.
11:8	RW	0	The direction for packets whose dimension is A.
7:4	RW	0	The direction for packets whose dimension is 9.
3:0	RW	0	The direction for packets whose dimension is 8.

**0x0D:** Directions 8-15

## D.12 DEBUG\_N configuration, tile 0: 0x10

Configures the behavior of the DEBUG\_N pin.

0x10: DEBUG\_N configuration, tile 0

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Set 1 to enable GlobalDebug to generate debug request to XCore.
0	RW	0	Set 1 to enable inDebug bit to drive GlobalDebug.

## D.13 DEBUG\_N configuration, tile 1: 0x11

Configures the behavior of the DEBUG\_N pin.

0x11: DEBUG\_N configuration, tile 1

Bits	Perm	Init	Description	
31:2	RO	-	eserved	
1	RW	0	et 1 to enable GlobalDebug to generate debug request to XCore.	
0	RW	0	Set 1 to enable inDebug bit to drive GlobalDebug.	

## D.14 Debug source: 0x1F

Contains the source of the most recent debug event.

Bits	Perm	Init	Description	
31:5	RO	-	eserved	
4	RW		If set, external pin, is the source of last GlobalDebug event.	
3:2	RO	-	Reserved	
1	RW		If set, XCore1 is the source of last GlobalDebug event.	
0	RW		If set, XCore0 is the source of last GlobalDebug event.	

**0x1F:** Debug source

## D.15 Link status, direction, and network: 0x20 .. 0x28

These registers contain status information for low level debugging (read-only), the network number that each link belongs to, and the direction that each link is part of. The registers control links 0..7.

Bits	Perm	Init	Description	
31:26	RO	-	Reserved	
25:24	RO		Identify the SRC_TARGET type 0 - SLink, 1 - PLink, 2 - SSCTL, 3 - Undefine.	
23:16	RO		When the link is in use, this is the destination link number to which all packets are sent.	
15:12	RO	-	Reserved	
11:8	RW	0	The direction that this link operates in.	
7:6	RO	-	Reserved	
5:4	RW	0	Determines the network to which this link belongs, reset as 0.	
3	RO	-	Reserved	
2	RO		1 when the current packet is considered junk and will be thrown away.	
1	RO		1 when the dest side of the link is in use.	
0	RO		1 when the source side of the link is in use.	

0x20 .. 0x28: Link status, direction, and network

#### D.16 PLink status and network: 0x40 ... 0x47

These registers contain status information and the network number that each processor-link belongs to.

		_		
Bits	Perm	Init	Description	
31:26	RO	-	Reserved	
25:24	RO		Identify the SRC_TARGET type $0$ - SLink, $1$ - PLink, $2$ - SSCTL, $3$ - Undefine.	
23:16	RO		When the link is in use, this is the destination link number to which all packets are sent.	
15:6	RO	-	Reserved	
5:4	RW	0	Determines the network to which this link belongs, reset as 0.	
3	RO	-	Reserved	
2	RO		1 when the current packet is considered junk and will be thrown away.	
1	RO		1 when the dest side of the link is in use.	
0	RO		1 when the source side of the link is in use.	

0x40 .. 0x47: PLink status and network

## D.17 Link configuration and initialization: 0x80 .. 0x88

These registers contain configuration and debugging information specific to external links. The link speed and width can be set, the link can be initialized, and the link status can be monitored. The registers control links 0..7.

Bits	Perm	Init	Description	
31			Write to this bit with '1' will enable the XLink, writing '0' will disable it. This bit controls the muxing of ports with overlapping xlinks.	
30	RW	0	0: operate in 2 wire mode; 1: operate in 5 wire mode	
29:28	RO	-	Reserved	
27	RO		Rx buffer overflow or illegal token encoding received.	
26	RO	0	This end of the xlink has issued credit to allow the remote end to transmit	
25	RO	0	This end of the xlink has credit to allow it to transmit.	
24	WO		Clear this end of the xlink's credit and issue a HELLO token.	
23	WO		Reset the receiver. The next symbol that is detected will be the first symbol in a token.	
22	RO	-	Reserved	
21:11	RW	0	Specify min. number of idle system clocks between two continuous symbols witin a transmit token -1.	
10:0	RW	0	Specify min. number of idle system clocks between two continuous transmit tokens -1.	

0x80 .. 0x88: Link configuration and initialization

## D.18 Static link configuration: 0xA0 .. 0xA7

These registers are used for static (ie, non-routed) links. When a link is made static, all traffic is forwarded to the designated channel end and no routing is attempted. The registers control links C, D, A, B, G, H, E, and F in that order.

Bits	Perm	Init	Description	
31	RW	0	Enable static forwarding.	
30:9	RO	-	Reserved	
8	RW	0	The destination processor on this node that packets received in static mode are forwarded to.	
7:5	RO	-	Reserved	
4:0	RW	0	The destination channel end on this node that packets received in static mode are forwarded to	

**0xA0 .. 0xA7:** Static link configuration

#### E Device Errata

This section describes minor operational differences from the data sheet and recommended workarounds. As device and documentation issues become known, this section will be updated the document revised.

To guarantee a logic low is seen on the pins RST\_N, DEBUG\_N, MODE[1:0], TRST\_N, TMS, and TDI, the driving circuit should present an impedance of less than  $100\,\Omega$  to ground. Usually this is not a problem for CMOS drivers driving single inputs. If one or more of these inputs are placed in parallel, however, additional logic buffers may be required to guarantee correct operation.

For static inputs tied high or low, the relevant input pin should be tied directly to GND or VDDIO.

## F JTAG, xSCOPE and Debugging

If you intend to design a board that can be used with the XMOS toolchain and xTAG debugger, you will need an xSYS header on your board. Figure 33 shows a decision diagram which explains what type of xSYS connectivity you need. The three subsections below explain the options in detail.

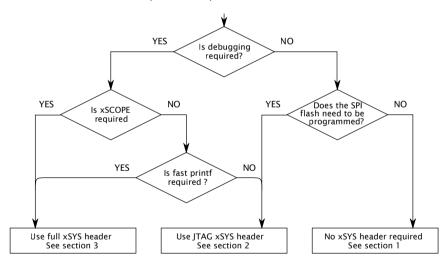


Figure 33:

Decision diagram for the xSYS header

#### F.1 No xSYS header

The use of an xSYS header is optional, and may not be required for volume production designs. However, the XMOS toolchain expects the xSYS header; if you do not have an xSYS header then you must provide your own method for writing to flash/OTP and for debugging.

#### F.2 JTAG-only xSYS header

The xSYS header connects to an xTAG debugger, which has a 20-pin 0.1" female IDC header. The design will hence need a male IDC header. We advise to use a boxed header to guard against incorrect plug-ins. If you use a 90 degree angled header, make sure that pins 2, 4, 6, ..., 20 are along the edge of the PCB.

Connect pins 4, 8, 12, 16, 20 of the xSYS header to ground, and then connect:

- ▶ TDI to pin 5 of the xSYS header
- ▶ TMS to pin 7 of the xSYS header
- ▶ TCK to pin 9 of the xSYS header
- ▶ DEBUG\_N to pin 11 of the xSYS header
- ▶ TDO to pin 13 of the xSYS header

The RST\_N net should be open-drain, active-low, and have a pull-up to VDDIO.

#### F.3 Full xSYS header

For a full xSYS header you will need to connect the pins as discussed in Section F.2, and then connect a 2-wire xCONNECT Link to the xSYS header. The links can be found in the Signal description table (Section 4): they are labelled XL0, XL1, etc in the function column. The 2-wire link comprises two inputs and outputs, labelled  $_{out}^1, _{out}^0, _{in}^0$ , and  $_{in}^1$ . For example, if you choose to use XL0 for xSCOPE I/O, you need to connect up  $\mathrm{XL0}_{out}^1, \mathrm{XL0}_{out}^1, \mathrm{XL0}_{in}^1, \mathrm{XL0}_{in}^1$  as follows:

- XLO<sub>out</sub> (X0D43) to pin 6 of the xSYS header with a 33R series resistor close to the device.
- XLO<sub>out</sub> (XOD42) to pin 10 of the xSYS header with a 33R series resistor close to the device.
- ► XL0<sup>0</sup><sub>in</sub> (X0D41) to pin 14 of the xSYS header.
- ► XL0<sup>1</sup><sub>in</sub> (X0D40) to pin 18 of the xSYS header.

## G Schematics Design Check List

This section is a checklist for use by schematics designers using the XL216-512-FB236. Each of the following sections contains items to check for each design.

#### G.1 Power supplies

	VDDIO and OTP_VCC supply is within specification before the VDD (core) supply is turned on. Specifically, the VDDIO and OTP_VCC supply is within specification before VDD (core) reaches 0.4V (Section 11).
	The VDD (core) supply ramps monotonically (rises constantly) from 0V to its final value (0.95V - 1.05V) within 10ms (Section 11).
	The VDD (core) supply is capable of supplying 600mA (Section 11).
	PLL_AVDD is filtered with a low pass filter, for example an RC filter, see Section 11
<b>G.2</b>	Power supply decoupling
П	The design has multiple decoupling capacitors per supply, for example

# value, per supply (Section 11). A bulk decoupling capacitor of at least 10uF is placed on each supply

at least four0402 or 0603 size surface mount capacitors of 100nF in

#### **G.3** Power on reset

(Section 11).

The RST\_N and TRST\_N pins are asserted (low) during or after power up. The device is not used until these resets have taken place.

As the errata in the datasheets show, the internal pull-ups on these two pins can occasionally provide stronger than normal pull-up currents. For this reason, an RC type reset circuit is discouraged as behavior would be unpredictable. A voltage supervisor type reset device is recommended to guarantee a good reset. This also has the benefit of resetting the system should the relevant supply go out of specification.

#### G.4 Clock

The CLK input pin is supplied with a clock with monotonic rising edges and low jitter.

	Pins MODE0 and MODE1 are set to the correct value for the chosen oscillator frequency. The MODE settings are shown in the Oscillator section, Section 7. If you have a choice between two values, choose the value with the highest multiplier ratio since that will boot faster.
G.5	Boot
	The device is connected to a QSPI flash for booting, connected to X0D01, X0D04X0D07, and X0D10 (Section 8). If not, you must boot the device through OTP or JTAG, or set it to boot from SPI and connect a SPI flash.
	The Flash that you have chosen is supported by <b>xflash</b> , or you have created a specification file for it.
G.6	JTAG, XScope, and debugging
	You have decided as to whether you need an XSYS header or not (Section $\mathbf{F}$ )
	If you have not included an XSYS header, you have devised a method to program the SPI-flash or OTP (Section F).
G.7	GPIO
	You have not mapped both inputs and outputs to the same multi-bit port.
	port.
	Pins X0D04, X0D05, X0D06, and X0D07 are output only and are, after reset, pulled high and low appropriately (Section 8)
_	Pins X0D04, X0D05, X0D06, and X0D07 are output only and are, after
G.8	Pins X0D04, X0D05, X0D06, and X0D07 are output only and are, after reset, pulled high and low appropriately (Section 8)
G.8	Pins X0D04, X0D05, X0D06, and X0D07 are output only and are, after reset, pulled high and low appropriately (Section 8)  Multi device designs
<b>G.8</b> Skip	Pins X0D04, X0D05, X0D06, and X0D07 are output only and are, after reset, pulled high and low appropriately (Section 8)  Multi device designs this section if your design only includes a single XMOS device.

# H PCB Layout Design Check List

M	This section is a checklist for use by PCB designers using the XS2-L16A-512-FB236. Each of the following sections contains items to check for each design.
H.1	Ground Plane
	Each ground ball has a via to minimize impedance and conduct heat away from the device. (Section 11.2)
	Other than ground vias, there are no (or only a few) vias underneath or closely around the device. This create a good, solid, ground plane.
H.2	Power supply decoupling
	The decoupling capacitors are all placed close to a supply pin (Section 11).
	The decoupling capacitors are spaced around the device (Section 11).
	The ground side of each decoupling capacitor has a direct path back to the center ground of the device.
Н.3	PLL_AVDD
	The PLL_AVDD filter (especially the capacitor) is placed close to the

# I Associated Design Documentation

Document Title	Information	Document Number
Estimating Power Consumption For XS1-L Devices	Power consumption	X4271
Programming XC on XMOS Devices	Timers, ports, clocks, cores and channels	X9577
xTIMEcomposer User Guide	Compilers, assembler and linker/mapper	X3766
	Timing analyzer, xScope, debugger	
	Flash and OTP programming utilities	

## J Related Documentation

Document Title	Information	Document Number
The XMOS XS1 Architecture	ISA manual	X7879
XS1 Port I/O Timing	Port timings	X5821
xCONNECT Architecture	Link, switch and system information	X4249
XS1-L Link Performance and Design Guidelines	Link timings	X2999
XS1-L Clock Frequency Control	Advanced clock control	X1433
XS1-L Active Power Conservation	Low-power mode during idle	X7411

## **K** Revision History

Date	Description	
2015-03-20	Preliminary release	
2015-04-14	Added RST to pins to be pulled hard, and removed reference to TCK from Errata	
	Removed TRST_N references in packages that have no TRST_N	
2015-05-06	Removed references tro DEBUG_N	
2015-07-09	Updated electrical characteristics - Section 12	
2015-08-27	Updated part marking - Section 14	



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